

Intel[®] Desktop Board D945PLNM Technical Product Specification

April 2006

Order Number: D44279-001US

The Intel[®] Desktop Board D945PLNM may contain design defects or errors known as errata that may cause the product to deviate from published specifications. Current characterized errata are documented in the Intel Desktop Board D945PLNM Specification Update.

Revision History

Revision	Revision History	Date
-001	First release of the Intel [®] Desktop Board D945PLNM Technical Product Specification.	April 2006

This product specification applies to only the standard Intel Desktop Board D945PLNM with BIOS identifier NM94510J.86A.

Changes to this specification will be published in the Intel Desktop Board D945PLNM Specification Update before being incorporated into a revision of this document.

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Preface

This Technical Product Specification (TPS) specifies the board layout, components, connectors, power and environmental requirements, and the BIOS for the Intel® Desktop Board D945PLNM. It describes the standard product and available manufacturing options.

Intended Audience

The TPS is intended to provide detailed, technical information about the Desktop Board D945PLNM and its components to the vendors, system integrators, and other engineers and technicians who need this level of information. It is specifically *not* intended for general audiences.

What This Document Contains

Description Chapter

- 1 A description of the hardware used on the Desktop Board D945PLNM
- 2 A map of the resources of the Desktop Board
- 3 The features supported by the BIOS Setup program
- 4 A description of the BIOS error messages, beep codes, and POST codes

Typographical Conventions

This section contains information about the conventions used in this specification. Not all of these symbols and abbreviations appear in all specifications of this type.

Notes, Cautions, and Warnings

■> NOTE

Notes call attention to important information.



INTEGRATOR'S NOTES

Integrator's notes are used to call attention to information that may be useful to system integrators.



Cautions are included to help you avoid damaging hardware or losing data.



Warnings indicate conditions, which if not observed, can cause personal injury.

#	Used after a signal name to identify an active-low signal (such as USBP0#)
(NxnX)	When used in the description of a component, N indicates component type, xn are the relative coordinates of its location on the Desktop Board D945PLNM, and X is the instance of the particular part at that general location. For example, J5J1 is a connector, located at 5J. It is the first connector in the 5J area.
GB	Gigabyte (1,073,741,824 bytes)
GB/sec	Gigabytes per second
Gbits/sec	Gigabits per second
KB	Kilobyte (1024 bytes)
Kbit	Kilobit (1024 bits)
kbits/sec	1000 bits per second
MB	Megabyte (1,048,576 bytes)
MB/sec	Megabytes per second
Mbit	Megabit (1,048,576 bits)
Mbit/sec	Megabits per second
xxh	An address or data value ending with a lowercase h indicates a hexadecimal value.
x.x V	Volts. Voltages are DC unless otherwise specified.
*	This symbol is used to indicate third-party brands and names that are the property of their respective owners.

Other Common Notation

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1.1 Overview

1.1.1 Feature Summary

Table 1 summarizes the major features of the board.

Form Factor	microATX (9.60 inches by 9.60 inches [243.84 millimeters by 243.84 millimeters])
Processor	Support for the following:
	Intel® Pentium® D processor in an LGA775 socket with an 800 MHz system bus
	 Intel[®] Pentium[®] 4 processor in an LGA775 socket with an 800 or 533 MHz system bus
	• Intel® Celeron® D processor in an LGA775 socket with a 533 MHz system bus
Memory	 Two 240-pin DDR2 SDRAM Dual Inline Memory Module (DIMM) sockets Support for DDR2 533 or DDR2 400 MHz DIMMs
	 Support for up to 2 GB of system memory
Chipset	Intel® 945PL Chipset, consisting of:
empoor	Intel [®] 82945PL Memory Controller Hub (MCH)
	 Intel[®] 82801G I/O Controller Hub (ICH7)
Audio	6-channel (5.1) audio subsystem with three analog audio outputs using the
Audio	Sigmatel* 9220 audio codec
Legacy I/O Control	Legacy I/O controller for diskette drive, serial, parallel, and PS/2* ports
USB	Support for USB 2.0 devices
	Support for USB anti-theft circuitry on back-panel USB connectors (requires the use of Intel® Platform Administrator Technology software, available separately)
Peripheral	Eight USB ports
Interfaces	One serial port
	One parallel port
	Four Serial ATA interfaces
	One Parallel ATA IDE interface with UDMA 33, ATA-66/100 support
	One diskette drive interface
	PS/2 keyboard and mouse ports
LAN Support	10/100 Mbits/sec LAN subsystem using the Intel® 82562GX Platform LAN Connect (PLC) device with ASF 1.03 support
BIOS	Intel [®] BIOS (resident in the SPI Flash device)
	Support for Advanced Configuration and Power Interface (ACPI), Plug and Play, and SMBIOS
Expansion	Two PCI Conventional* bus connectors
Capabilities	One PCI Express* x1 bus add-in card connector
	One PCI Express x16 bus add-in card connector

Table 1.	Feature Summary
----------	-----------------

continued

Instantly Available	Support for PCI Local Bus Specification Revision 2.3
PC Technology	Support for PCI Express Revision 1.0a
	Suspend to RAM support
	Wake on PCI, RS-232, front panel, PS/2 devices, and USB ports
Hardware Monitor	Hardware monitoring and fan control ASIC
Subsystem	Voltage sense to detect out of range power supply voltages
	Thermal sense to detect out of range thermal values
	Three fan connectors
	Three fan sense inputs used to monitor fan activity
	Fan speed control

 Table 1.
 Feature Summary (continued)

For information about	Refer to
Available configurations for the board	Section 1.2, page 15

1.1.2 Board Layout

Figure 1 shows the location of the major components.

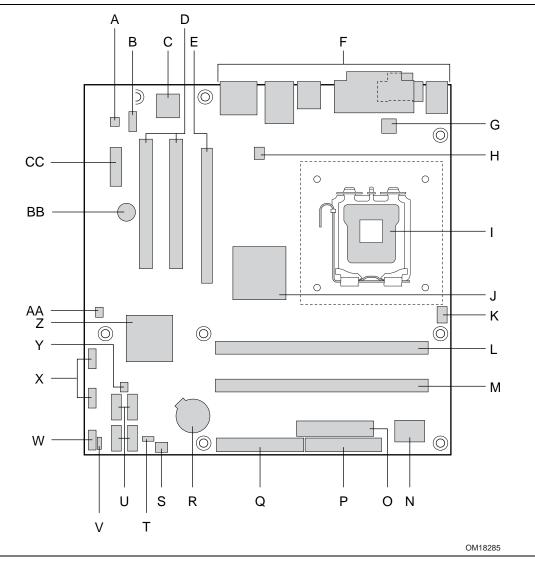


Figure 1. Board Components

Table 2 lists the components identified in Figure 1.

Item/callout from Figure 1	Description
A	Audio codec
В	Front panel audio connector
С	Ethernet device
D	PCI Conventional bus add-in card connectors [2]
E	PCI Express x16 bus add-in card connector
F	Back panel connectors
G	+12V power connector (ATX12V)
Н	Rear chassis fan connector
I	LGA775 processor socket
J	Intel 82945PL MCH
K	Processor fan connector
L	DIMM Channel A socket
М	DIMM Channel B socket
Ν	Legacy I/O controller
0	Power connector
Р	Diskette drive connector
Q	Parallel ATE IDE connector
R	Battery
S	Front chassis fan connector
Т	BIOS Setup configuration jumper block
U	Serial ATA connectors [4]
V	Auxiliary front panel power LED connector
W	Front panel connector
Х	Front panel USB connectors [2]
Y	Chassis intrusion connector
Z	Intel 82801G I/O Controller Hub (ICH7)
AA	SPI flash device
BB	Speaker
CC	PCI Express x1 bus add-in card connector

 Table 2.
 Board Components Shown in Figure 1

1.1.3 Block Diagram

Figure 2 is a block diagram of the major functional areas.

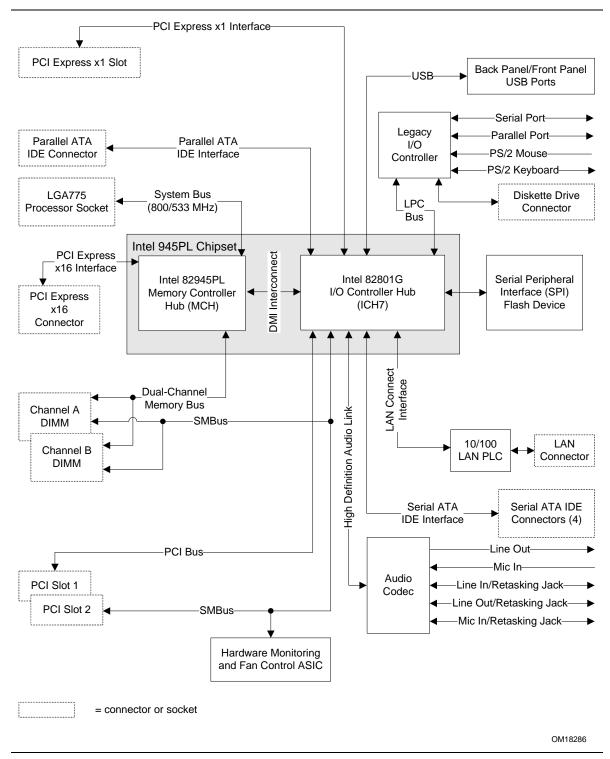


Figure 2. Block Diagram

1.2 Online Support

To find information about	Visit this World Wide Web site:
Intel [®] Desktop Board D945PLNM under "Desktop Board Products" or "Desktop	http://www.intel.com/design/motherbd
Board Support"	http://support.intel.com/support/motherboards/desktop
Available configurations for the Desktop Board D945PLNM	http://developer.intel.com/design/motherbd/nm/nm_available.htm
Processor data sheets	http://www.intel.com/design/litcentr
ICH7 addressing	http://developer.intel.com/products/chipsets
Custom splash screens	http://intel.com/design/motherbd/gen_indx.htm
Audio software and utilities	http://www.intel.com/design/motherbd
LAN software and drivers	http://www.intel.com/design/motherbd

1.3 Processor

The board is designed to support the following processors:

- Intel Pentium D processor in an LGA775 processor socket with an 800 MHz system bus ٠
- Intel Pentium 4 processor in an LGA775 processor socket with an 800 or 533 MHz system bus •
- Intel Celeron D processor in an LGA775 processor socket with a 533 MHz system bus ٠

See the Intel web site listed below for the most up-to-date list of supported processors.

For information about	Refer to:
Supported processors	http://www.intel.com/design/motherbd/nm/nm_proc.htm

Use only the processors listed on web site above. Use of unsupported processors can damage the board, the processor, and the power supply.



K INTEGRATOR'S NOTE

Use only ATX12V-compliant power supplies.

For information about	Refer to
Power supply connectors	Section 2.7.2.1, page 51

1.4 System Memory

The board has two DIMM sockets and support the following memory features:

- 1.8 V (only) DDR2 SDRAM DIMMs with gold-plated contacts
- Unbuffered, single-sided or double-sided DIMMs with the following restriction:

Double-sided DIMMS with x16 organization are not supported

- 2 GB maximum total system memory
- Minimum total system memory: 128 MB
- Non-ECC DIMMs
- Serial Presence Detect
- DDR2 533 or DDR2 400 MHz SDRAM DIMMs

NOTES

- *Remove the PCI Express x16 video card before installing or upgrading memory to avoid interference with the memory retention mechanism.*
- To be fully compliant with all applicable DDR SDRAM memory specifications, the board should be populated with DIMMs that support the Serial Presence Detect (SPD) data structure. This allows the BIOS to read the SPD data and program the chipset to accurately configure memory settings for optimum performance. If non-SPD memory is installed, the BIOS will attempt to correctly configure the memory settings, but performance and reliability may be impacted or the DIMMs may not function under the determined frequency.

Table 3 lists the supported DIMM configurations.

DIMM Capacity	Configuration	SDRAM Density	SDRAM Organization Front-side/Back-side	Number of SDRAM Devices
128 MB	SS	256 Mbit	16 M x 16/empty	4
256 MB	SS	256 Mbit	32 M x 8/empty	8
256 MB	SS	512 Mbit	32 M x 16/empty	4
512 MB	DS	256 Mbit	32 M x 8/32 M x 8	16
512 MB	SS	512 Mbit	64 M x 8/empty	8
512 MB	SS	1 Gbit	64 M x 16/empty	4
1024 MB	SS	1 Gbit	128 M x 8/empty	8

Table 3. Supported Memory Configurations

Note: In the second column, "DS" refers to double-sided memory modules (containing two rows of SDRAM) and "SS" refers to single-sided memory modules (containing one row of SDRAM).

1.4.1 Memory Configurations

The Intel 82945PL MCH supports two types of memory organization:

- **Dual channel (Interleaved) mode**. This mode offers the highest throughput for real world applications. Dual channel mode is enabled when the installed memory capacities of both DIMM channels are equal. Technology and device width can vary from one channel to the other but the installed memory capacity for each channel must be equal. If different speed DIMMs are used between channels, the slowest memory timing will be used.
- **Single channel (Asymmetric) mode**. This mode is equivalent to single channel bandwidth operation for real world applications. This mode is used when only a single DIMM is installed or the memory capacities are unequal. Technology and device width can vary from one channel to the other. If different speed DIMMs are used between channels, the slowest memory timing will be used.

Figure 3 illustrates the memory channel and DIMM configuration.

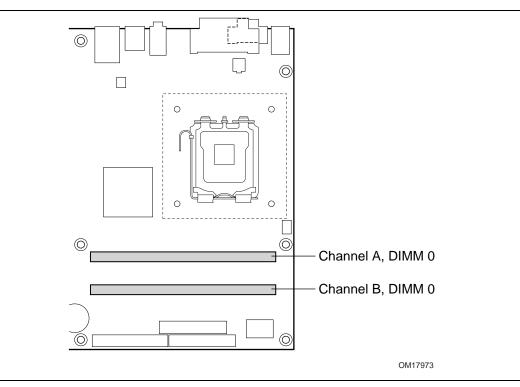


Figure 3. Memory Channel and DIMM Configuration

1.4.1.1 Dual Channel (Interleaved) Mode Configuration

Figure 4 shows a dual channel configuration using two DIMMs. In this example, the DIMM sockets are populated with identical DIMMs.

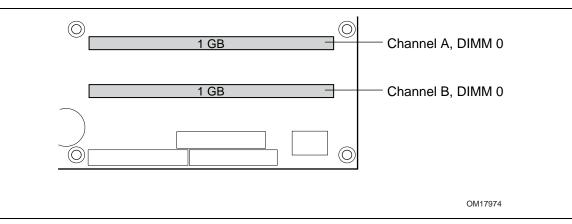


Figure 4. Dual Channel (Interleaved) Mode Configuration with Two DIMMs

1.4.1.2 Single Channel (Asymmetric) Mode Configurations

■> NOTE

Dual channel (Interleaved) mode configurations provide the highest memory throughput.

Figure 5 shows a single channel configuration using one DIMM. In this example, only Channel A is populated. Channel B is not populated.

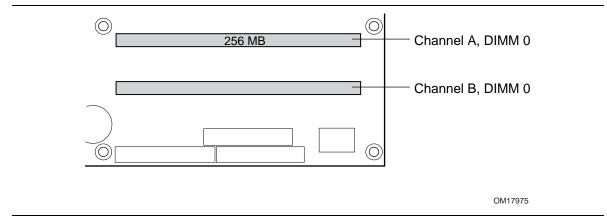


Figure 5. Single Channel (Asymmetric) Mode Configuration with One DIMM

Figure 6 shows a single channel configuration using two DIMMs. In this example, the capacity of the DIMM in Channel A does not equal the capacity of the DIMM in Channel B.

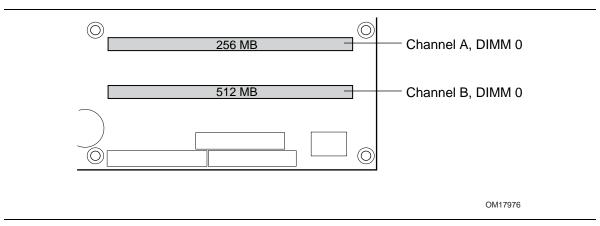


Figure 6. Single Channel (Asymmetric) Mode Configuration with Two DIMMs

1.5 Intel® 945PL Chipset

The Intel 945PL chipset consists of the following devices:

- Intel 82945PL Memory Controller Hub (MCH) with Direct Media Interface (DMI) interconnect
- Intel 82801G I/O Controller Hub (ICH7) with DMI interconnect

The MCH component provides interfaces to the CPU, memory, PCI Express, and the DMI interconnect. The ICH7 is a centralized controller for the board's I/O paths.

For information about	Refer to
The Intel 945PL chipset	http://developer.intel.com/
Resources used by the chipset	Chapter 2

1.5.1 USB

The board supports up to eight USB 2.0 ports, supports UHCI and EHCI, and uses UHCI- and EHCI-compatible drivers.

The ICH7 provides the USB controller for all ports. The port arrangement is as follows:

- Four ports are implemented with dual stacked back panel connectors adjacent to the audio connectors. These connectors are yellow, indicating that they support USB anti-theft circuitry.
- Four ports are routed to two separate front panel USB connectors. These connectors do not support USB anti-theft circuitry.

■> NOTE

USB anti-theft circuitry requires the use of Intel[®] Platform Administration Technology software. Contact your Intel representative for more information.

≡> NOTE

Computer systems that have an unshielded cable attached to a USB port may not meet FCC Class B requirements, even if no device is attached to the cable. Use shielded cable that meets the requirements for full-speed devices.

For information about	Refer to
The location of the USB connectors on the back panel	Figure 12, page 47
The location of the front panel USB connectors	Figure 13, page 48

1.5.2 IDE Support

The board provides five IDE interface connectors:

- One parallel ATA IDE connector that supports two devices
- Four serial ATA IDE connectors that support one device per connector

1.5.2.1 Parallel ATE IDE Interface

The ICH7's Parallel ATA IDE controller has one bus-mastering Parallel ATA IDE interface. The Parallel ATA IDE interface supports the following modes:

- Programmed I/O (PIO): processor controls data transfer.
- 8237-style DMA: DMA offloads the processor, supporting transfer rates of up to 16 MB/sec.
- Ultra DMA: DMA protocol on IDE bus supporting host and target throttling and transfer rates of up to 33 MB/sec.
- ATA-66: DMA protocol on IDE bus supporting host and target throttling and transfer rates of up to 66 MB/sec. ATA-66 protocol is similar to Ultra DMA and is device driver compatible.
- ATA-100: DMA protocol on IDE bus allows host and target throttling. The ICH7's ATA-100 logic can achieve read transfer rates up to 100 MB/sec and write transfer rates up to 88 MB/sec.

NOTE

ATA-66 and ATA-100 are faster timings and require a specialized cable to reduce reflections, noise, and inductive coupling.

The Parallel ATA IDE interface also supports ATAPI devices (such as CD-ROM drives) and ATA devices using the transfer modes.

The BIOS supports Logical Block Addressing (LBA) and Extended Cylinder Head Sector (ECHS) translation modes. The drive reports the transfer rate and translation mode to the BIOS.

For information about	Refer to
The location of the Parallel ATA IDE connector	Figure 13, page 48

1.5.2.2 Serial ATA Interfaces

The ICH7's Serial ATA controller offers four independent Serial ATA ports with a theoretical maximum transfer rate of 3 Gbits/sec per port. One device can be installed on each port for a maximum of four Serial ATA devices. A point-to-point interface is used for host to device connections, unlike Parallel ATA IDE which supports a master/slave configuration and two devices per channel.

For compatibility, the underlying Serial ATA functionality is transparent to the operating system. The Serial ATA controller can operate in both legacy and native modes. In legacy mode, standard IDE I/O and IRQ resources are assigned (IRQ 14 and 15). In Native mode, standard PCI Conventional bus resource steering is used. Native mode is the preferred mode for configurations using the Windows* XP and Windows 2000 operating systems.

■> NOTE

Many Serial ATA drives use new low-voltage power connectors and require adaptors or power supplies equipped with low-voltage power connectors.

For more information, see: http://www.serialata.org/

For information about	Refer to
The location of the Serial ATA IDE connectors	Figure 13, page 48

Real-Time Clock, CMOS SRAM, and Battery 1.5.3

A coin-cell battery (CR2032) powers the real-time clock and CMOS memory. When the computer is not plugged into a wall socket, the battery has an estimated life of three years. When the computer is plugged in, the standby current from the power supply extends the life of the battery. The clock is accurate to \pm 13 minutes/year at 25 °C with 3.3 VSB applied.

NOTE

If the battery and AC power fail, custom defaults, if previously saved, will be loaded into CMOS *RAM at power-on.*

When the voltage drops below a certain level, the BIOS Setup program settings stored in CMOS RAM (for example, the date and time) might not be accurate. Replace the battery with an equivalent one. Figure 1 on page 12 shows the location of the battery.

CAUTION

Risk of explosion if the battery is replaced with an incorrect type. Batteries should be recycled where possible. Disposal of used batteries must be in accordance with local environmental regulations.



PRECAUTION

Risque d'explosion si la pile usagée est remplacée par une pile de type incorrect. Les piles usagées doivent être recyclées dans la mesure du possible. La mise au rebut des piles usagées doit respecter les réglementations locales en vigueur en matière de protection de l'environnement.

FORHOLDSREGEL

Eksplosionsfare, hvis batteriet erstattes med et batteri af en forkert type. Batterier bør om muligt genbruges. Bortskaffelse af brugte batterier bør foregå i overensstemmelse med gældende miljølovgivning.



Det kan oppstå eksplosjonsfare hvis batteriet skiftes ut med feil type. Brukte batterier bør kastes i henhold til gjeldende miljølovgivning.

VIKTIGT!

Risk för explosion om batteriet ersätts med felaktig batterityp. Batterier ska kasseras enligt de lokala miljövårdsbestämmelserna.

ڬ VARO

Räjähdysvaara, jos pariston tyyppi on väärä. Paristot on kierrätettävä, jos se on mahdollista. Käytetyt paristot on hävitettävä paikallisten ympäristömääräysten mukaisesti.



🛝 VORSICHT

Bei falschem Einsetzen einer neuen Batterie besteht Explosionsgefahr. Die Batterie darf nur durch denselben oder einen entsprechenden, vom Hersteller empfohlenen Batterietyp ersetzt werden. Entsorgen Sie verbrauchte Batterien den Anweisungen des Herstellers entsprechend.



🔼 AVVERTIMENTO

Esiste il pericolo di un esplosione se la pila non viene sostituita in modo corretto. Utilizzare solo pile uguali o di tipo equivalente a quelle consigliate dal produttore. Per disfarsi delle pile usate, seguire le istruzioni del produttore.

🖺 PRECAUCIÓN

Existe peligro de explosión si la pila no se cambia de forma adecuada. Utilice solamente pilas iguales o del mismo tipo que las recomendadas por el fabricante del equipo. Para deshacerse de las pilas usadas, siga igualmente las instrucciones del fabricante.



🔼 WAARSCHUWING

Er bestaat ontploffingsgevaar als de batterij wordt vervangen door een onjuist type batterij. Batterijen moeten zoveel mogelijk worden gerecycled. Houd u bij het weggooien van gebruikte batterijen aan de plaatselijke milieuwetgeving.



🛝 ATENÇÃO

Haverá risco de explosão se a bateria for substituída por um tipo de bateria incorreto. As baterias devem ser recicladas nos locais apropriados. A eliminação de baterias usadas deve ser feita de acordo com as regulamentações ambientais da região.



🖺 AŚCIAROŽZNAŚĆ

Існуе рызыка выбуху, калі заменены акумулятар неправільнага тыпу. Акумулятары павінны, па магчымасці, перепрацоўвацца. Пазбаўляцца ад старых акумулятараў патрэбна згодна з мясцовым заканадаўствам па экалогіі.



UPOZORNÌNÍ

V případě výměny baterie za nesprávný druh může dojít k výbuchu. Je-li to možné, baterie by měly být recyklovány. Baterie je třeba zlikvidovat v souladu s místními předpisy o životním prostředí.



🛝 Προσοχή

Υπάρχει κίνδυνος για έκρηζη σε περίπτωση που η μπαταρία αντικατασταθεί από μία λανθασμένου τύπου. Οι μπαταρίες θα πρέπει να ανακυκλώνονται όταν κάτι τέτοιο είναι δυνατό. Η απόρριψη των χρησιμοποιημένων μπαταριών πρέπει να γίνεται σύμφωνα με τους κατά τόπο περιβαλλοντικούς κανονισμούς.



🗥 VIGYAZAT

Ha a telepet nem a megfelelő típusú telepre cseréli, az felrobbanhat. A telepeket lehetőség szerint újra kell hasznosítani. A használt telepeket a helyi környezetvédelmi előírásoknak megfelelően kell kiselejtezni.

<u> 注</u>意

異なる種類の電池を使用すると、爆発の危険があります。リサイクル が可能な地域であれば、電池をリサイクルしてください。使用後の電 池を破棄する際には、地域の環境規制に従ってください。

🔼 AWAS

Risiko letupan wujud jika bateri digantikan dengan jenis yang tidak betul. Bateri sepatutnya dikitar semula jika boleh. Pelupusan bateri terpakai mestilah mematuhi peraturan alam sekitar tempatan.

🗥 ostrzeżenie

Istnieje niebezpieczeństwo wybuchu w przypadku zastosowania niewłaściwego typu baterii. Zużyte baterie należy w miarę możliwości utylizować zgodnie z odpowiednimi przepisami ochrony środowiska.

<u> PRECAUTIE</u>

Risc de explozie, dacă bateria este înlocuită cu un tip de baterie necorespunzător. Bateriile trebuie reciclate, dacă este posibil. Depozitarea bateriilor uzate trebuie să respecte reglementările locale privind protecția mediului.

<u> В</u>НИМАНИЕ

При использовании батареи несоответствующего типа существует риск ее взрыва. Батареи должны быть утилизированы по возможности. Утилизация батарей должна проводится по правилам, соответствующим местным требованиям.

UPOZORNENIE

Ak batériu vymeníte za nesprávny typ, hrozí nebezpečenstvo jej výbuchu. Batérie by sa mali podľa možnosti vždy recyklovať. Likvidácia použitých batérií sa musí vykonávať v súlade s miestnymi predpismi na ochranu životného prostredia.

Zamenjava baterije z baterijo drugačnega tipa lahko povzroči eksplozijo. Če je mogoče, baterije reciklirajte. Rabljene baterije zavrzite v skladu z lokalnimi okoljevarstvenimi predpisi.

🔼 คำเตือน

ระวังการระเบิดที่เกิดจากเปลี่ยนแบตเตอรี่ผิดประเภท หากเป็นไปได้ ควรนำแบตเตอรี่ไปรีไซเคิล การ ทิ้งแบตเตอรี่ใช้แล้วต้องเป็นไปตามกฎข้อบังคับด้านสิ่งแวดล้อมของท้องถิ่น.

🕛 UYARI

Yanlış türde pil takıldığında patlama riski vardır. Piller mümkün olduğunda geri dönüştürülmelidir. Kullanılmış piller, yerel çevre yasalarına uygun olarak atılmalıdır.

🛝 осторога

Використовуйте батареї правильного типу, інакше існуватиме ризик вибуху. Якщо можливо, використані батареї слід утилізувати. Утилізація використаних батарей має бути виконана згідно місцевих норм, що регулюють охорону довкілля.

🖺 upozornění

V případě výměny baterie za nesprávný druh může dojít k výbuchu. Je-li to možné, baterie by měly být recyklovány. Baterie je třeba zlikvidovat v souladu s místními předpisy o životním prostředí.



🖺 ETTEVAATUST

Kui patarei asendatakse uue ebasobivat tüüpi patareiga, võib tekkida plahvatusoht. Tühjad patareid tuleb võimaluse korral viia vastavasse kogumispunkti. Tühjade patareide äraviskamisel tuleb järgida kohalikke keskkonnakaitse alaseid reegleid.

🗥 FIGYELMEZTETÉS

Ha az elemet nem a megfelelő típusúra cseréli, felrobbanhat. Az elemeket lehetőség szerint újra kell hasznosítani. A használt elemeket a helyi környezetvédelmi előírásoknak megfelelően kell kiselejtezni.



🖺 UZMANĪBU

Pastāv eksplozijas risks, ja baterijas tiek nomainītas ar nepareiza veida baterijām. Ja iespējams, baterijas vajadzētu nodot attiecīgos pieņemšanas punktos. Bateriju izmešanai atkritumos jānotiek saskaņā ar vietējiem vides aizsardzības noteikumiem.



🗥 DĖMESIO

Naudojant netinkamo tipo baterijas įrenginys gali sprogti. Kai tik įmanoma, baterijas reikia naudoti pakartotinai. Panaudotas baterijas išmesti būtina pagal vietinius aplinkos apsaugos nuostatus.

🛝 ATTENZJONI

Riskju ta' splužjoni jekk il-batterija tinbidel b'tip ta' batterija mhux korrett. Il-batteriji għandhom jiģu riċiklati fejn hu possibbli. Ir-rimi ta' batteriji użati għandu jsir skond ir-regolamenti ambjentali lokali.

\land OSTRZEŻENIE

Ryzyko wybuchu w przypadku wymiany na baterie niewłaściwego typu. W miarę możliwości baterie należy poddać recyklingowi. Zużytych baterii należy pozbywać się zgodnie z lokalnie obowiązującymi przepisami w zakresie ochrony środowiska.

1.6 PCI Express* Connectors

The board provides the following PCI Express connectors:

- One PCI Express x16 connector supporting simultaneous transfer speeds up to 4 GBytes/sec of peak bandwidth per direction and up to 8 GBytes/sec concurrent bandwidth
- One PCI Express x1 connector. The x1 interface support simultaneous transfer speeds up to 250 Mbytes/sec of peak bandwidth per direction and up to 500 MBytes/sec concurrent bandwidth

The PCI Express interface supports the PCI Conventional bus configuration mechanism so that the underlying PCI Express architecture is compatible with PCI Conventional compliant operating systems. Additional features of the PCI Express interface include the following:

- Support for the PCI Express enhanced configuration mechanism
- Automatic discovery, link training, and initialization
- Support for Active State Power Management (ASPM)
- SMBus 2.0 support
- Wake# signal supporting wake events from ACPI S1, S3, S4, or S5
- Software compatible with the PCI Power Management Event (PME) mechanism defined in the PCI Power Management Specification Rev. 1.1

1.7 Legacy I/O Controller

The legacy I/O controller provides the following features:

- One serial port
- One parallel port with Extended Capabilities Port (ECP) and Enhanced Parallel Port (EPP) support
- Serial IRQ interface compatible with serialized IRQ support for PCI Conventional bus systems
- PS/2-style mouse and keyboard interfaces
- Interface for one 1.44 MB or 2.88 MB diskette drive
- Intelligent power management, including a programmable wake-up event interface
- PCI Conventional bus power management support

The BIOS Setup program provides configuration options for the legacy I/O controller.

1.7.1 Serial Port

The Serial port A connector is located on the back panel. The serial port supports data transfers at speeds up to 115.2 kbits/sec with BIOS support.

For information about	Refer to
The location of the serial port A connector	Figure 12, page 47

1.7.2 Parallel Port

The 25-pin D-Sub parallel port connector is located on the back panel. Use the BIOS Setup program to set the parallel port mode.

For information about	Refer to
The location of the parallel port connector	Figure 12, page 47

1.7.3 Diskette Drive Controller

The legacy I/O controller supports one diskette drive. Use the BIOS Setup program to configure the diskette drive interface.

For information about	Refer to
The location of the diskette drive connector	Figure 13, page 48

1.7.4 Keyboard and Mouse Interface

PS/2 keyboard and mouse connectors are located on the back panel.

■> NOTE

The keyboard is supported in the bottom PS/2 connector and the mouse is supported in the top PS/2 connector. Power to the computer should be turned off before a keyboard or mouse is connected or disconnected.

For information about	Refer to
The location of the keyboard and mouse connectors	Figure 12, page 47

1.8 Audio Subsystem

The board supports the Intel[®] High Definition audio subsystem based on the Sigmatel 9220 audio codec. The audio subsystem supports the following features:

- Advanced jack sense for the back panel audio jacks that enables the audio codec to recognize the device that is connected to an audio port. The back panel audio jacks are capable of retasking according to user's definition, or can be automatically switched depending on the recognized device type.
- Stereo input and output for all back panel jacks
- Line out and Mic in functions for front panel audio jacks
- A signal-to-noise (S/N) ratio of 95 dB

1.8.1 Audio Subsystem Software

Audio software and drivers are available from Intel's World Wide Web site.

For information about	Refer to
Obtaining audio software and drivers	Section 1.2, page 15

1.8.2 Audio Connectors

The board contains audio connectors on both the back panel and the component side of the board. The front panel audio connector provides mic in and line out signals for the front panel.

For information about	Refer to
The location of the front panel audio connector	Figure 13, page 48
The signal names of the front panel audio connector	Table 16, page 50
The back panel audio connectors	Section 2.7.1, page 47

1.8.3 6-Channel (5.1) Audio Subsystem

The 6-channel (5.1) audio subsystem includes the following:

- Intel 82801G I/O Controller Hub (ICH7)
- Sigmatel 9220 audio codec
- Microphone input that supports a single dynamic, condenser, or electret microphone

The back panel audio connectors are configurable through the audio device drivers. The available configurable audio ports are shown in Figure 7.

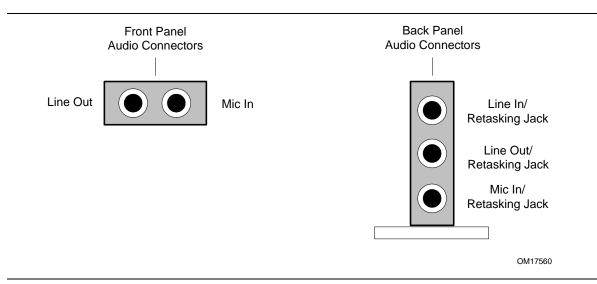


Figure 7. Front/Back Panel Audio Connector Options for 6-Channel (5.1) Audio Subsystem

Figure 8 is a block diagram of the 6-channel (5.1) audio subsystem.

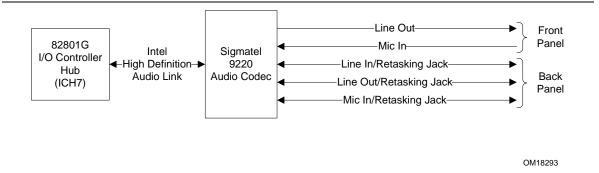


Figure 8. 6-Channel (5.1) Audio Subsystem Block Diagram

For information about	Refer to
The back panel audio connectors	Section 2.7.1, page 47

1.9 LAN Subsystem

The LAN subsystem consists of the following:

- Physical layer interface device Intel 82562GX PLC for 10/100 Mbits/sec Ethernet LAN connectivity.
- RJ-45 LAN connector with integrated status LEDs

Additional features of the LAN subsystem include:

- CSMA/CD protocol engine
- LAN connect interface that supports the 82562GX
- PCI Conventional bus power management
 - Supports ACPI technology
 - Supports LAN wake capabilities

1.9.1 10/100 Mbits/sec LAN Subsystem

The 10/100 Mbits/sec LAN subsystem includes the ICH6, the Intel 82562GX PLC, and an RJ-45 LAN connector with integrated status LEDs.

1.9.1.1 Intel[®] 82562GX Physical Layer Interface Device

The Intel 82562GX provides the following functions:

- Basic 10/100 Ethernet LAN connectivity
- Full device driver compatibility
- Programmable transit threshold
- Configuration EEPROM that contains the MAC address
- Alert Standard Format (ASF) 1.03 support

1.9.1.2 RJ-45 LAN Connector with Integrated LEDs

Two LEDs are built into the RJ-45 LAN connector (shown in Figure 9).

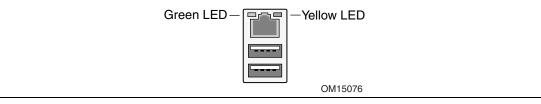


Figure 9. LAN Connector LED Locations

Table 4 describes the LED states when the board is powered up and the 10/100 Mbits/sec LAN subsystem is operating.

LED Color	LED State	Condition
Green	Off	LAN link is not established.
	On	LAN link is established.
	Blinking	LAN activity is occurring.
Yellow	Off	10 Mbits/sec data rate is selected.
	On	100 Mbits/sec data rate is selected.

Table 4. LAN Connector LED States

1.9.2 Alert Standard Format (ASF) Support

The board provides the following ASF support for PCI Express x1 bus add-in LAN cards and PCI Conventional bus add-in LAN cards installed in PCI Conventional bus slot 2:

- Monitoring of system firmware progress events, including:
 - BIOS present
 - Primary processor initialization
 - Memory initialization
 - Video initialization
 - PCI resource configuration
 - Hard-disk initialization
 - User authentication
 - Starting operating system boot process
- Monitoring of system firmware error events, including:
 - Memory missing
 - Memory failure
 - No video device
 - Keyboard failure
 - Hard-disk failure
 - No boot media
- Boot options to boot from different types of boot devices
- Reset, shutdown, power cycle, and power up options

1.9.3 LAN Subsystem Software

LAN software and drivers are available from Intel's World Wide Web site.

For information about	Refer to
Obtaining LAN software and drivers	Section 1.2, page 15

1.10 Hardware Management Subsystem

The hardware management features enable the board to be compatible with the Wired for Management (WfM) specification. The board has several hardware management features, including the following:

- Chassis intrusion detection
- Fan monitoring and control (through the hardware monitoring and fan control ASIC)
- Thermal and voltage monitoring

1.10.1 Hardware Monitoring and Fan Control ASIC

The features of the hardware monitoring and fan control ASIC include:

- Internal ambient temperature sensor
- Two remote thermal diode sensors for direct monitoring of processor temperature and ambient temperature sensing
- Power supply monitoring of five voltages (+5 V, +12 V, +3.3 VSB, and +VCCP) to detect levels above or below acceptable values
- Thermally monitored closed-loop fan control, for all three fans, that can adjust the fan speed or switch the fans on or off as needed
- SMBus interface

For information about	Refer to
The location of the fan connectors and sensors for thermal monitoring	Figure 10, page 34

1.10.2 Chassis Intrusion and Detection

The board supports a chassis security feature that detects if the chassis cover is removed. The security feature uses a mechanical switch on the chassis that attaches to the chassis intrusion connector. When the chassis cover is removed, the mechanical switch is in the closed position.

1.10.3 Fan Monitoring

Fan monitoring can be implemented using Intel Desktop Utilities or third-party software. The level of monitoring and control is dependent on the hardware monitoring ASIC used with the board.

For information about	Refer to
The functions of the fan connectors	Section 1.11.2.2, page 38

1.10.4 Thermal Monitoring

Figure 10 shows the location of the sensors and fan connectors.

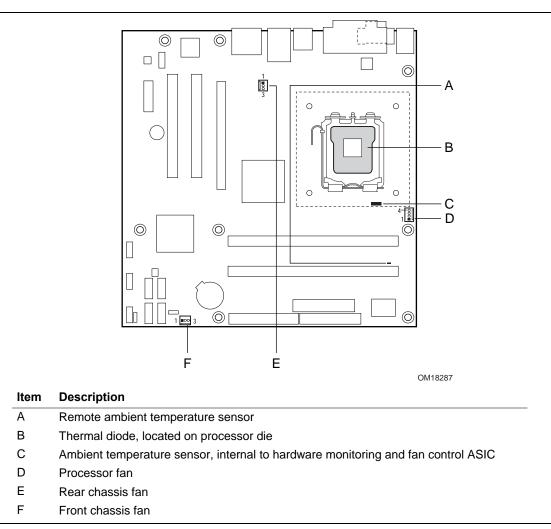


Figure 10. Thermal Sensors and Fan Connectors

1.11 Power Management

Power management is implemented at several levels, including:

- Software support through Advanced Configuration and Power Interface (ACPI)
- Hardware support:
 - Power connector
 - Fan connectors
 - LAN wake capabilities
 - Instantly Available PC technology
 - Resume on Ring
 - Wake from USB
 - Wake from PS/2 devices
 - Power Management Event signal (PME#) wake-up support

1.11.1 ACPI

ACPI gives the operating system direct control over the power management and Plug and Play functions of a computer. The use of ACPI with this board requires an operating system that provides full ACPI support. ACPI features include:

- Plug and Play (including bus and device enumeration)
- Power management control of individual devices, add-in boards (some add-in boards may require an ACPI-aware driver), video displays, and hard disk drives
- Methods for achieving less than 15-watt system operation in the power-on/standby sleeping state
- A Soft-off feature that enables the operating system to power-off the computer
- Support for multiple wake-up events (see Table 7 on page 37)
- Support for a front panel power and sleep mode switch

Table 5 lists the system states based on how long the power switch is pressed, depending on how ACPI is configured with an ACPI-aware operating system.

If the system is in this state…	and the power switch is pressed for	the system enters this state
Off (ACPI G2/G5 – Soft off)	Less than four seconds	Power-on (ACPI G0 – working state)
On (ACPI G0 – working state)	Less than four seconds	Soft-off/Standby (ACPI G1 – sleeping state)
On (ACPI G0 – working state)	More than four seconds	Fail safe power-off (ACPI G2/G5 – Soft off)
Sleep (ACPI G1 – sleeping state)	Less than four seconds	Wake-up (ACPI G0 – working state)
Sleep (ACPI G1 – sleeping state)	More than four seconds	Power-off (ACPI G2/G5 – Soft off)

Table 5. Effects of Pressing the Power Switch

1.11.1.1 System States and Power States

Under ACPI, the operating system directs all system and device power state transitions. The operating system puts devices in and out of low-power states based on user preferences and knowledge of how devices are being used by applications. Devices that are not being used can be turned off. The operating system uses information from applications and user settings to put the system as a whole into a low-power state.

Table 6 lists the power states supported by the board along with the associated system power targets. See the ACPI specification for a complete description of the various system and power states.

Global States	Sleeping States	Processor States	Device States	Targeted System Power (Note 1)
G0 – working state	S0 – working	C0 – working	D0 – working state.	Full power > 30 W
G1 – sleeping state	S1 – Processor stopped	C1 – stop grant	D1, D2, D3 – device specification specific.	5 W < power < 52.5 W
G1 – sleeping state	S3 – Suspend to RAM. Context saved to RAM.	No power	D3 – no power except for wake-up logic.	Power < 5 W (Note 2)
G1 – sleeping state	S4 – Suspend to disk. Context saved to disk.	No power	D3 – no power except for wake-up logic.	Power < 5 W (Note 2)
G2/S5	S5 – Soft off. Context not saved. Cold boot is required.	No power	D3 – no power except for wake-up logic.	Power < 5 W (Note 2)
G3 – mechanical off AC power is disconnected from the computer.	No power to the system.	No power	D3 – no power for wake-up logic, except when provided by battery or external source.	No power to the system. Service can be performed safely.

Table 6. Power States and Targeted System Power

Notes:

1. Total system power is dependent on the system configuration, including add-in boards and peripherals powered by the system chassis' power supply.

2. Dependent on the standby power consumption of wake-up devices used in the system.

1.11.1.2 Wake-up Devices and Events

Table 7 lists the devices or specific events that can wake the computer from specific states.

These devices/events can wake up the computer	from this state	
LAN	S1, S3, S4, S5 (Note)	
Modem (back panel Serial Port A)	S1, S3	
PME# signal	S1, S3, S4, S5 (Note)	
Power switch	S1, S3, S4, S5	
PS/2 devices	S1, S3	
RTC alarm	S1, S3, S4, S5	
USB	S1, S3	
WAKE# signal	S1, S3, S4, S5	

Table 7. Wake-up Devices and Events

Note: For LAN and PME# signal, S5 is disabled by default in the BIOS Setup program. Setting this option to Power On will enable a wake-up event from LAN in the S5 state.

NOTES

- The board does not support S3 Wake on LAN using IP ping with ASF enabled.
- The use of these wake-up events from an ACPI state requires an operating system that provides full ACPI support. In addition, software, drivers, and peripherals must fully support ACPI wake events.

1.11.2 Hardware Support

Ensure that the power supply provides adequate +5 V standby current if LAN wake capabilities and Instantly Available PC technology features are used. Failure to do so can damage the power supply. The total amount of standby current required depends on the wake devices supported and manufacturing options.

The board provides several power management hardware features, including:

- Power connector
- Fan connectors
- LAN wake capabilities
- Instantly Available PC technology
- Resume on Ring
- Wake from USB
- Wake from PS/2 keyboard
- PME# signal wake-up support
- WAKE# signal wake-up support

LAN wake capabilities and Instantly Available PC technology require power from the +5 V standby line.

Resume on Ring enables telephony devices to access the computer when it is in a power-managed state. The method used depends on the type of telephony device (external or internal).

■> NOTE

The use of Resume on Ring and Wake from USB technologies from an ACPI state requires an operating system that provides full ACPI support.

1.11.2.1 Power Connector

ATX12V-compliant power supplies can turn off the system power through system control. When an ACPI-enabled system receives the correct command, the power supply removes all non-standby voltages.

When resuming from an AC power failure, the computer returns to the power state it was in before power was interrupted (on or off). The computer's response can be set using the Last Power State feature in the BIOS Setup program's Boot menu.

For information about	Refer to
The location of the main power connector	Figure 13, page 48
The signal names of the main power connector	Table 21, page 51

1.11.2.2 Fan Connectors

The function/operation of the fan connectors is as follows:

- The fans are on when the board is in the S0 or S1 state.
- The fans are off when the board is off or in the S3, S4, or S5 state.
- Each fan connector is wired to a fan tachometer input of the hardware monitoring and fan control ASIC.
- All fan connectors support closed-loop fan control that can adjust the fan speed or switch the fan on or off as needed.
- All fan connectors have a +12 V DC connection.

For information about	Refer to	
The location of the fan connectors	Figure 13, page 48	
The location of the fan connectors and sensors for thermal monitoring	Figure 10, page 34	
The signal names of the processor fan connector	Table 19, page 50	
The signal names of the chassis fan connectors	Table 20, page 50	

1.11.2.3 LAN Wake Capabilities

For LAN wake capabilities, the +5 V standby line for the power supply must be capable of providing adequate +5 V standby current. Failure to provide adequate standby current when implementing LAN wake capabilities can damage the power supply.

LAN wake capabilities enable remote wake-up of the computer through a network. The LAN network adapter monitors network traffic at the Media Independent Interface. Upon detecting a

Magic Packet* frame, the LAN subsystem asserts a wake-up signal that powers up the computer. Depending on the LAN implementation, the board supports LAN wake capabilities with ACPI in the following ways:

- The PCI Express WAKE# signal
- The PCI Conventional bus PME# signal for PCI 2.3 compliant LAN designs
- The onboard LAN subsystem

1.11.2.4 Instantly Available PC Technology

For Instantly Available PC technology, the +5 V standby line for the power supply must be capable of providing adequate +5 V standby current. Failure to provide adequate standby current when implementing Instantly Available PC technology can damage the power supply.

Instantly Available PC technology enables the board to enter the ACPI S3 (Suspend-to-RAM) sleep-state. While in the S3 sleep-state, the computer will appear to be off (the power supply is off, and the front panel LED is amber if dual colored, or off if single colored.) When signaled by a wake-up device or event, the system quickly returns to its last known wake state. Table 7 on page 37 lists the devices and events that can wake the computer from the S3 state.

The board supports the *PCI Bus Power Management Interface Specification*. Add-in boards that also support this specification can participate in power management and can be used to wake the computer.

The use of Instantly Available PC technology requires operating system support and PCI 2.3 compliant add-in cards, PCI Express add-in cards, and drivers.

1.11.2.5 Resume on Ring

The operation of Resume on Ring can be summarized as follows:

- Resumes operation from ACPI S1 or S3 states
- Detects incoming call similarly for external and internal modems
- Requires modem interrupt be unmasked for correct operation

1.11.2.6 Wake from USB

USB bus activity wakes the computer from ACPI S1 or S3 states.

NOTE

Wake from USB requires the use of a USB peripheral that supports Wake from USB.

1.11.2.7 Wake from PS/2 Devices

PS/2 device activity wakes the computer from an ACPI S1 or S3 state.

1.11.2.8 PME# Signal Wake-up Support

When the PME# signal on the PCI Conventional bus is asserted, the computer wakes from an ACPI S1, S3, S4, or S5 state (with Wake on PME enabled in BIOS).

1.11.2.9 WAKE# Signal Wake-up Support

When the WAKE# signal on the PCI Express bus is asserted, the computer wakes from an ACPI S1, S3, S4, or S5 state.

1.11.2.10 +5 V Standby Power Indicator LED

The +5 V standby power indicator LED shows that power is still present even when the computer appears to be off. Figure 11 shows the location of the standby power indicator LED.

If AC power has been switched off and the standby power indicator is still lit, disconnect the power cord before installing or removing any devices connected to the board. Failure to do so could damage the board and any attached devices.

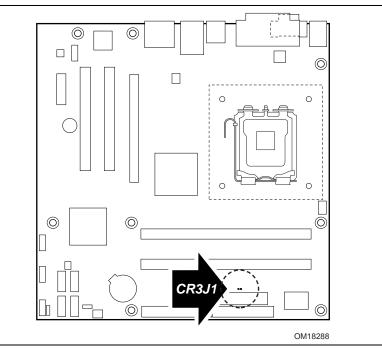


Figure 11. Location of the Standby Power Indicator LED

What This Chapter Contains

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	Memory Map Fixed I/O Map. DMA Channels. PCI Configuration Space Map. Interrupts. PCI Conventional Interrupt Routing Map Connectors. Jumper Block Mechanical Considerations. Electrical Considerations. Thermal Considerations. Reliability. Environmental Regulatory Compliance.

2.1 Memory Map

Table 8 lists the system memory map.

Table 8.	System Me	mory Map
----------	-----------	----------

Address Range (decimal)	Address Range (hex)	Size	Description
1024 K - 2097152 K	100000 - 7FFFFFFF	2047 MB	Extended memory
960 K - 1024 K	F0000 - FFFFF	64 KB	Runtime BIOS
896 K - 960 K	E0000 - EFFFF	64 KB	Reserved
800 K - 896 K	C8000 - DFFFF	96 KB	Potential available high DOS memory (open to the PCI Conventional bus). Dependent on video adapter used.
640 K - 800 K	A0000 - C7FFF	160 KB	Video memory and BIOS
639 K - 640 K	9FC00 - 9FFFF	1 KB	Extended BIOS data (movable by memory manager software)
512 K - 639 K	80000 - 9FBFF	127 KB	Extended conventional memory
0 K - 512 K	00000 - 7FFFF	512 KB	Conventional memory

2.2 Fixed I/O Map

Address (hex)	Size	Description
0000 - 00FF	256 bytes	Used by the Desktop Board D945PLNM. Refer to the ICH7 data sheet for dynamic addressing information.
0170 - 0177	8 bytes	Secondary Parallel ATA IDE channel command block
01F0 - 01F7	8 bytes	Primary Parallel ATA IDE channel command block
0228 - 022F (Note 1)	8 bytes	LPT3
0278 - 027F (Note 1)	8 bytes	LPT2
02E8 - 02EF (Note 1)	8 bytes	COM4
02F8 - 02FF (Note 1)	8 bytes	COM2
0374 - 0377	4 bytes	Secondary Parallel ATA IDE channel control block
0377, bits 6:0	7 bits	Secondary IDE channel status port
0378 - 037F	8 bytes	LPT1
03E8 - 03EF	8 bytes	COM3
03F0 - 03F5	6 bytes	Diskette channel
03F4 – 03F7	1 byte	Primary Parallel ATA IDE channel control block
03F8 - 03FF	8 bytes	COM1
04D0 - 04D1	2 bytes	Edge/level triggered PIC
LPTn + 400	8 bytes	ECP port, LPTn base address + 400h
0CF8 - 0CFB (Note 2)	4 bytes	PCI Conventional bus configuration address register
0CF9 (Note 3)	1 byte	Reset control register
0CFC - 0CFF	4 bytes	PCI Conventional bus configuration data register
FFA0 - FFA7	8 bytes	Primary Parallel ATA IDE bus master registers
FFA8 - FFAF	8 bytes	Secondary Parallel ATA IDE bus master registers

Notes:

1. Default, but can be changed to another address range

2. Dword access only

3. Byte access only

■> NOTE

Some additional I/O addresses are not available due to ICH7 address aliasing. The ICH7 data sheet provides more information on address aliasing.

For information about	Refer to
Obtaining the ICH7 data sheet	Section 1.2, page 15

2.3 DMA Channels

DMA Channel Number	Data Width	System Resource	
0	8 or 16 bits	Open	
1	8 or 16 bits	Parallel port	
2	8 or 16 bits	Diskette drive	
3	8 or 16 bits	Parallel port (for ECP or EPP)	
4	8 or 16 bits	DMA controller	
5	16 bits	Open	
6	16 bits	Open	
7	16 bits	Open	

2.4 PCI Configuration Space Map

Bus Number (hex)	Device Number (hex)	Function Number (hex)	Description
00	00	00	Memory controller of Intel 82945PL component
00	01	00	PCI Express x16 graphics port (Note 1)
00	1B	00	Intel High Definition Audio Controller
00	1C	00	PCI Express port 1
00	1C	01	PCI Express port 2
00	1C	02	PCI Express port 3
00	1C	03	PCI Express port 4
00	1D	00	USB UHCI controller 1
00	1D	01	USB UHCI controller 2
00	1D	02	USB UHCI controller 3
00	1D	03	USB UHCI controller 4
00	1D	07	EHCI controller
00	1E	00	PCI bridge
00	1F	00	PCI controller
00	1F	01	Parallel ATA IDE controller
00	1F	02	Serial ATA controller
00	1F	03	SMBus controller
(Note 2)	00	00	PCI Conventional bus connector 1
(Note 2)	01	00	PCI Conventional bus connector 2
(Note 2)	08	00	Intel® 82562 10/100 Mbits/sec LAN PLC
01	00	00	PCI Express video controller (if present) (Note 1)

Table 11. PCI Configuration Space Map

Notes:

1. Present only when a PCI Express x16 graphics card is installed.

2. Bus number is dynamic and can change based on add-in cards used.

2.5 Interrupts

The interrupts can be routed through either the Programmable Interrupt Controller (PIC) or the Advanced Programmable Interrupt Controller (APIC) portion of the ICH7 component. The PIC is supported in Windows 98 SE and Windows ME and uses the first 16 interrupts. The APIC is supported in Windows 2000 and Windows XP and supports a total of 24 interrupts.

IRQ	System Resource
NMI	I/O channel check
0	Reserved, interval timer
1	Reserved, keyboard buffer full
2	Reserved, cascade interrupt from slave PIC
3	User available
4	COM1 (Note 1)
5	User available
6	Diskette drive
7	LPT1 (Note 1)
8	Real-time clock
9	User available
10	User available
11	User available
12	Onboard mouse port (if present, else user available)
13	Reserved, math coprocessor
14	Primary Parallel ATA/Serial ATA – Legacy Mode (if present, else user available)
15	Secondary Parallel ATA/Serial ATA – Legacy Mode (if present, else user available)
16 (Note 2)	User available (through PIRQA)
17 (Note 2)	User available (through PIRQB)
18 (Note 2)	User available (through PIRQC)
19 (Note 2)	User available (through PIRQD)
20 (Note 2)	User available (through PIRQE)
21 (Note 2)	User available (through PIRQF)
22 (Note 2)	User available (through PIRQG)
23 (Note 2)	User available (through PIRQH)

Table 12. Interrupts

Notes:

1. Default, but can be changed to another IRQ.

2. Available in APIC mode only.

2.6 PCI Conventional* Interrupt Routing Map

This section describes interrupt sharing and how the interrupt signals are connected between the PCI Conventional bus connectors and onboard PCI Conventional devices. The PCI Conventional specification describes how interrupts can be shared between devices attached to the PCI Conventional bus. In most cases, the small amount of latency added by interrupt sharing does not affect the operation or throughput of the devices. In some special cases where maximum performance is needed from a device, a PCI Conventional device should not share an interrupt with other PCI Conventional devices. Use the following information to avoid sharing an interrupt with a PCI Conventional add-in card.

PCI Conventional devices are categorized as follows to specify their interrupt grouping:

- INTA: By default, all add-in cards that require only one interrupt are in this category. For almost all cards that require more than one interrupt, the first interrupt on the card is also classified as INTA.
- INTB: Generally, the second interrupt on add-in cards that require two or more interrupts is classified as INTB. (This is not an absolute requirement.)
- INTC and INTD: Generally, a third interrupt on add-in cards is classified as INTC and a fourth interrupt is classified as INTD.

The ICH7 has eight Programmable Interrupt Request (PIRQ) input signals. All PCI Conventional interrupt sources either onboard or from a PCI Conventional add-in card connect to one of these PIRQ signals. Some PCI Conventional interrupt sources are electrically tied together on the board and therefore share the same interrupt. Table 13 shows an example of how the PIRQ signals are routed.

Table 13. PCI Interrupt Routing Map

		ICH7 PIRQ Signal Name						
PCI Interrupt Source	PIRQA	PIRQB	PIRQC	PIRQD	PIRQE	PIRQF	PIRQG	PIRQH
ICH7 LAN					INTA			
PCI bus connector 1					INTD	INTA	INTB	INTC
PCI bus connector 2					INTC	INTB	INTA	INTD

NOTE

In PIC mode, the ICH7 can connect each PIRQ line internally to one of the IRQ signals (3, 4, 5, 6, 7, 9, 10, 11, 12, 14, and 15). Typically, a device that does not share a PIRQ line will have a unique interrupt. However, in certain interrupt-constrained situations, it is possible for two or more of the PIRQ lines to be connected to the same IRQ signal. Refer to Table 12 for the allocation of PIRQ lines to IRQ signals in APIC mode.

PCI interrupt assignments to the USB ports, Serial ATA ports, and PCI Express ports are dynamic.

2.7 Connectors

Only the following connectors have overcurrent protection: back panel USB, front panel USB, and PS/2.

The other internal connectors are not overcurrent protected and should connect only to devices inside the computer's chassis, such as fans and internal peripherals. Do not use these connectors to power devices external to the computer's chassis. A fault in the load presented by the external devices could cause damage to the computer, the power cable, and the external devices themselves.

This section describes the board's connectors. The connectors can be divided into these groups:

- Back panel I/O connectors (see page 47)
- Component-side I/O connectors (see page 48)

2.7.1 Back Panel Connectors

Figure 12 shows the location of the back panel connectors. The back panel connectors are color-coded. The figure legend (Table 14) lists the colors used (when applicable).

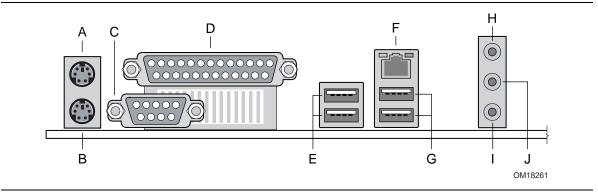


Figure 12. Back Panel Connectors

Table 14 lists the back panel connectors identified in Figure 12.

■> NOTE

The back panel audio line out connector is designed to power headphones or amplified speakers only. Poor audio quality occurs if passive (non-amplified) speakers are connected to this output.

Item/callout from Figure 12	Description	
A	PS/2 mouse port [Green]	
В	PS/2 keyboard port [Purple]	
С	Serial port A [Teal]	
D	Parallel port [Burgundy]	
E	USB ports (two) [Yellow]	
F	LAN	
G	USB ports (two) [Yellow]	
Н	Audio line in/Retasking Jack [Blue]	
I	Mic in/Retasking Jack [Pink]	
J	Front left/right channel audio out/Two channel audio line out/Retasking Jack [Lime green]	

 Table 14.
 Back Panel Connectors Shown in Figure 12

2.7.2 Component-side Connectors

Figure 13 shows the locations of the component-side connectors.

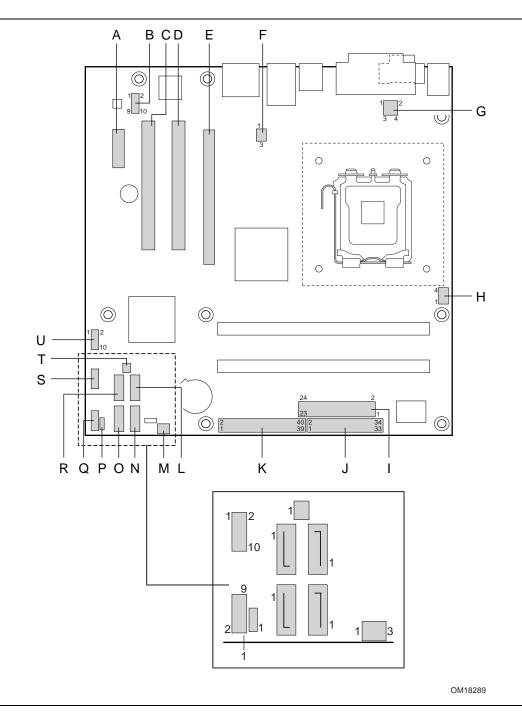


Figure 13. Component-side Connectors

Table 15 lists the component-side connectors identified in Figure 13.

Item/callout from Figure 13	Description	
A	PCI Express x1 bus add-in card connector	
В	Front panel audio connector	
С	PCI Conventional bus add-in card connector 2	
D	PCI Conventional bus add-in card connector 1	
E	PCI Express x16 bus add-in card connector	
F	Rear chassis fan connector	
G	+12V power connector (ATX12V)	
Н	Processor fan connector	
I	Power connector	
J	Diskette drive connector	
К	Parallel ATA IDE connector	
L	Serial ATA connector 3	
М	Front chassis fan connector	
N	Serial ATA connector 2	
0	Serial ATA connector 0	
Р	Auxiliary front panel power LED connector	
Q	Front panel connector	
R	Serial ATA connector 1	
S	Front panel USB connector	
Т	Chassis intrusion connector	
U	Front panel USB connector	

 Table 15.
 Component-side Connectors Shown in Figure 13

Pin	Signal Name	Pin	Signal Name
1	Port E [Port 1] Left Channel	2	Ground
3	Port E [Port 1] Right Channel	4	Presence# (dongle present)
5	Port F [Port 2] Right Channel	6	Port E [Port 1] Sense return (jack detection)
7	Port E [Port 1] and Port F [Port 2] Sense send (jack detection)	8	Кеу
9	Port F [Port 2] Left Channel	10	Port F [Port 2] Sense return (jack detection)

 Table 16.
 Front Panel Audio Connector

***** INTEGRATOR'S NOTE

The front panel audio connector is colored yellow.

Table 17.	Chassis	Intrusion	Connector
-----------	---------	-----------	-----------

Pin	Signal Name	
1	Intruder	
2	Ground	

Table 18. Serial ATA Connectors

Pin	Signal Name
1	Ground
2	ТХР
3	TXN
4	Ground
5	RXN
6	RXP
7	Ground

Table 19. Processor Fan Connector

Pin	Signal Name
1	Ground
2	+12 V
3	FAN_TACH
4	FAN_CONTROL

Table 20. Front and Rear Chassis Fan Connectors

Pin	Signal Name	
1	FAN_CONTROL	
2	+12 V	
3	FAN_TACH	

2.7.2.1 **Power Supply Connectors**

The board has power supply connectors:

- **Main power** $-a 2 \ge 12$ connector. This connector is compatible with $2 \ge 10$ connectors previously used on Intel Desktop boards. The board supports the use of ATX12V power supplies with either 2 x 10 or 2 x 12 main power cables. When using a power supply with a 2 x 10 main power cable, attach that cable on the rightmost pins of the main power connector, leaving pins 11, 12, 23, and 24 unconnected.
- ATX12V power a 2 x 2 connector. This connector provides power directly to the processor • voltage regulator and must always be used. Failure to do so will prevent the board from booting.



***** INTEGRATOR'S NOTE

When using high wattage PCI Express x16 graphics cards, use a power supply with a 2 x 12 main power cable. The 2×12 main power cable can provide up to 144 W of power from the +12 V rail.

Pin	Signal Name	Pin	Signal Name
1	+3.3 V	13	+3.3 V
2	+3.3 V	14	-12 V
3	Ground	15	Ground
4	+5 V	16	PS-ON# (power supply remote on/off)
5	Ground	17	Ground
6	+5 V	18	Ground
7	Ground	19	Ground
8	PWRGD (Power Good)	20	No connect
9	+5 V (Standby)	21	+5 V
10	+12 V	22	+5 V
11	+12 V ^(Note)	23	+5 V (Note)
12	2 x 12 connector detect (Note)	24	Ground ^(Note)

Table 21. Main Power Connector

Note: When using a 2 x 10 power supply cable, this pin will be unconnected.

Table 22. ATX12V Power Connector

Pin	Signal Name	Pin	Signal Name
1	Ground	2	Ground
3	+12 V	4	+12 V

2.7.2.2 Add-in Card Connectors

The board has the following add-in card connectors:

- PCI Express x16: one connector supporting simultaneous transfer speeds up to 4 GBytes/sec of peak bandwidth per direction and up to 8 GBytes/sec concurrent bandwidth.
- PCI Express x1: one PCI Express x1 connector. The x1 interfaces support simultaneous transfer speeds up to 250 Mbytes/sec of peak bandwidth per direction and up to 500 MBytes/sec concurrent bandwidth.
- PCI Conventional (rev 2.3 compliant) bus: two PCI Conventional bus add-in card connectors. The SMBus is routed to PCI Conventional bus connector 2 only (ATX expansion slot 6). PCI Conventional bus add-in cards with SMBus support can access sensor data and other information residing on the board.

Note the following considerations for the PCI Conventional bus connectors:

- All of the PCI Conventional bus connectors are bus master capable.
- SMBus signals are routed to PCI Conventional bus connector 2. This enables PCI Conventional bus add-in boards with SMBus support to access sensor data on the boards. The specific SMBus signals are as follows:
 - The SMBus clock line is connected to pin A40.
 - The SMBus data line is connected to pin A41.

2.7.2.3 Auxiliary Front Panel Power/Sleep LED Connector

Pins 1 and 3 of this connector duplicate the signals on pins 2 and 4 of the front panel connector.

Pin	Signal Name	In/Out	Description
1	HDR_BLNK_GRN	Out	Front panel green LED
2	Not connected		
3	HDR_BLNK_YEL	Out	Front panel yellow LED

Table 23. Auxiliary Front Panel Power/Sleep LED Connector

2.7.2.4 Front Panel Connector

This section describes the functions of the front panel connector. Table 24 lists the signal names of the front panel connector. Figure 14 is a connection diagram for the front panel connector.

Pin	Signal	In/Out	Description	Pin	Signal	In/Out	Description
Hard Drive Activity LED [Yellow]						ower LEI [Green])
1	HD_PWR	Out	Hard disk LED pull-up (750 Ω) to +5 V	2	HDR_BLNK_ GRN	Out	Front panel green LED
3	HAD#	Out	Hard disk active LED	4	HDR_BLNK_ YEL	Out	Front panel yellow LED
Reset Switch [Purple]				On/	/Off Swit [Red]	ch	
5	Ground		Ground	6	FPBUT_IN	In	Power switch
7	FP_RESET#	In	Reset switch	8	Ground		Ground
Power				Not	Connect	ted	
9	+5 V		Power	10	N/C		Not connected

 Table 24.
 Front Panel Connector

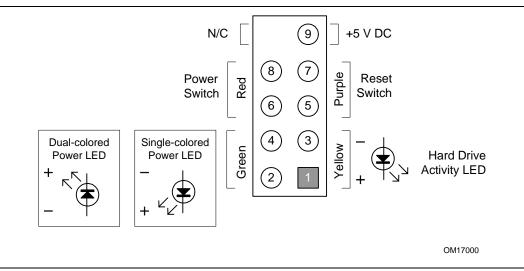


Figure 14. Connection Diagram for Front Panel Connector

2.7.2.4.1 Hard Drive Activity LED Connector [Yellow]

Pins 1 and 3 [Yellow] can be connected to an LED to provide a visual indicator that data is being read from or written to a hard drive. Proper LED function requires one of the following:

- A Serial ATA hard drive connected to an onboard Serial ATA connector
- An IDE hard drive connected to an onboard IDE connector

2.7.2.4.2 Reset Switch Connector [Purple]

Pins 5 and 7 [Purple] can be connected to a momentary single pole, single throw (SPST) type switch that is normally open. When the switch is closed, the board resets and runs the POST.

2.7.2.4.3 Power/Sleep LED Connector [Green]

Pins 2 and 4 [Green] can be connected to a one- or two-color LED. Table 25 shows the possible states for a one-color LED. Table 26 shows the possible states for a two-color LED.

Table 25. States for a One-Color Power LED

LED State	Description
Off	Power off/sleeping
Steady Green	Running

Table 26. States for a Two-Color Power LED	Table 26.	States	for a	Two-Color	Power LED
--	-----------	--------	-------	------------------	------------------

LED State	Description
Off	Power off
Steady Green	Running
Steady Yellow	Sleeping

■> NOTE

The colors listed in Table 25 and Table 26 are suggested colors only. Actual LED colors are product- or customer-specific.

2.7.2.4.4 Power Switch Connector [Red]

Pins 6 and 8 [Red] can be connected to a front panel momentary-contact power switch. The switch must pull the SW_ON# pin to ground for at least 50 ms to signal the power supply to switch on or off. (The time requirement is due to internal debounce circuitry on the board.) At least two seconds must pass before the power supply will recognize another on/off signal.

2.7.2.5 Front Panel USB Connectors

Figure 15 is a connection diagram for the front panel USB connectors.

***** INTEGRATOR'S NOTES

- The +5 V DC power on the USB connector is fused.
- Pins 1, 3, 5, and 7 comprise one USB port.
- Pins 2, 4, 6, and 8 comprise one USB port.
- Use only a front panel USB connector that conforms to the USB 2.0 specification for highspeed USB devices.
- These USB connectors do not support USB anti-theft circuitry.

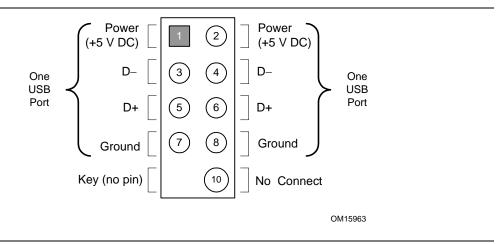


Figure 15. Connection Diagram for Front Panel USB Connectors

2.8 Jumper Block

Do not move the jumper with the power on. Always turn off the power and unplug the power cord from the computer before changing a jumper setting. Otherwise, the board could be damaged.

Figure 16 shows the location of the jumper block. The jumper block determines the BIOS Setup program's mode. Table 27 describes the jumper settings for the three modes: normal, configure, and recovery. When the jumper is set to configure mode and the computer is powered-up, the BIOS compares the processor version and the microcode version in the BIOS and reports if the two match.

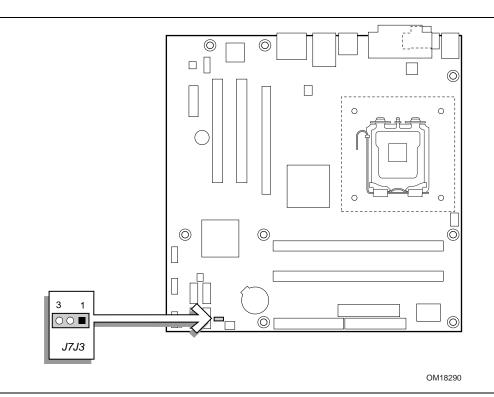


Figure 16. Location of the Jumper Block

Table 27.	BIOS Setup	Configuration	Jumper Settings

Function/Mode	Jumper	^r Setting	Configuration
Normal	1-2	3 0 1	The BIOS uses current configuration information and passwords for booting.
Configure	2-3	3	After the POST runs, Setup runs automatically. The maintenance menu is displayed.
Recovery	overy None 3 0001		The BIOS attempts to recover the BIOS configuration. A recovery diskette is required.

2.9 Mechanical Considerations

2.9.1 Form Factor

The board is designed to fit into an ATX-form-factor chassis. Figure 17 illustrates the mechanical form factor of the board. Dimensions are given in inches [millimeters]. The outer dimensions are 9.90 inches by 9.60 inches [243.84 millimeters by 243.84 millimeters]. Location of the I/O connectors and mounting holes are in compliance with the ATX specification.

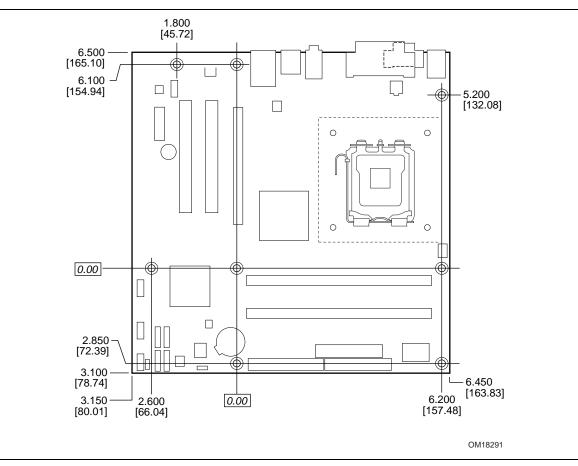


Figure 17. Board Dimensions

2.9.2 I/O Shield

The back panel I/O shield for the board must meet specific dimension and material requirements. Systems based on this board need the back panel I/O shield to pass certification testing. Figure 18 shows the I/O shield. Dimensions are given in millimeters [inches]. The figures also indicate the position of each cutout. Additional design considerations for I/O shields relative to chassis requirements are described in the ATX specification.

■> NOTE

The I/O shield drawings in this document are for reference only. I/O shields compliant with the ATX chassis specification 2.03 are available from Intel.

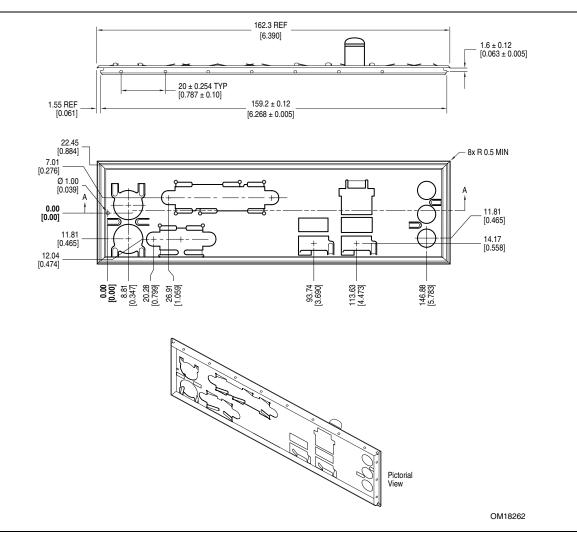


Figure 18. I/O Shield Dimensions

2.10 Electrical Considerations

2.10.1 DC Loading

Table 28 lists the DC loading characteristics of the boards. This data is based on a DC analysis of all active components within the board that impact its power delivery subsystems. The analysis does not include PCI add-in cards. Minimum values assume a light load placed on the board that is similar to an environment with no applications running and no USB current draw. Maximum values assume a load placed on the board that is similar to a heavy gaming environment with a 500 mA current draw per USB port. These calculations are not based on specific processor values or memory configurations but are based on the minimum and maximum current draw possible from the board's power delivery subsystems to the processor, memory, and USB ports.

Use the datasheets for add-in cards, such as PCI, to determine the overall system power requirements. The selection of a power supply at the system level is dependent on the system's usage model and not necessarily tied to a particular processor speed.

		DC Current at:				
Mode	DC Power	+3.3 V	+5 V	+12 V	-12 V	+5 VSB
Minimum loading	275 W	3.5 A	12 A	17 A	0 A	0.34 A (S0) 1.00 A (S3)
Maximum loading	500 W	16 A	23 A	29 A	0.20 A	0.34 A (S0) 1.10 A (S3)

Table 28. DC Loading Characteristics

2.10.2 Add-in Board Considerations

The board is designed to provide 2 A (average) of +5 V current for each add-in board. The total +5 V current draw for the board is as follows: a fully loaded D945PLNM board (all three expansion slots and the PCI Express x16 slot filled) must not exceed 8 A.

2.10.3 Fan Connector Current Capability

The processor fan must be connected to the processor fan connector, not to a chassis fan connector. Connecting the processor fan to a chassis fan connector may result in onboard component damage that will halt fan operation.

Table 29 lists the current capability of the fan connectors.

Fan Connector	Maximum Available Current
Processor fan	3.0 A
Front chassis fan	1.5 A
Rear chassis fan	1.5 A

Table 29. Fan Connector Current Capability

2.10.4 Power Supply Considerations

The +5 V standby line for the power supply must be capable of providing adequate +5 V standby current. Failure to do so can damage the power supply. The total amount of standby current required depends on the wake devices supported and manufacturing options.

System integrators should refer to the power usage values listed in Table 28 when selecting a power supply for use with the board.

Additional power required will depend on configurations chosen by the integrator.

The power supply must comply with the following recommendations found in the ATX form factor specification:

- The potential relation between 3.3 VDC and +5 VDC power rails
- The current capability of the +5 VSB line
- All timing parameters
- All voltage tolerances

2.11 Thermal Considerations

A chassis with a maximum internal ambient temperature of $38 \,^{\circ}C$ at the processor fan inlet is a requirement. Use a processor heatsink that provides omni-directional airflow (similar to the type shown in Figure 19) to maintain required airflow across the processor voltage regulator area.

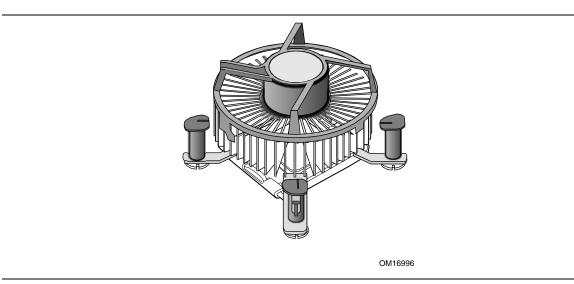


Figure 19. Processor Heatsink for Omni-directional Airflow

Failure to ensure appropriate airflow may result in reduced performance of both the processor and/or voltage regulator or, in some instances, damage to the board. For a list of chassis that have been tested with Intel desktop boards please refer to the following website:

http://developer.intel.com/design/motherbd/cooling.htm

All responsibility for determining the adequacy of any thermal or system design remains solely with the reader. Intel makes no warranties or representations that merely following the instructions presented in this document will result in a system with adequate thermal performance.

Ensure that the ambient temperature does not exceed the board's maximum operating temperature. Failure to do so could cause components to exceed their maximum case temperature and malfunction. For information about the maximum operating temperature, see the environmental specifications in Section 2.13.

Ensure that proper airflow is maintained in the processor voltage regulator circuit. Failure to do so may result in damage to the voltage regulator circuit. The processor voltage regulator area (item A in Figure 20) can reach a temperature of up to 85 °C in an open chassis.

Figure 20 shows the locations of the localized high temperature zones.

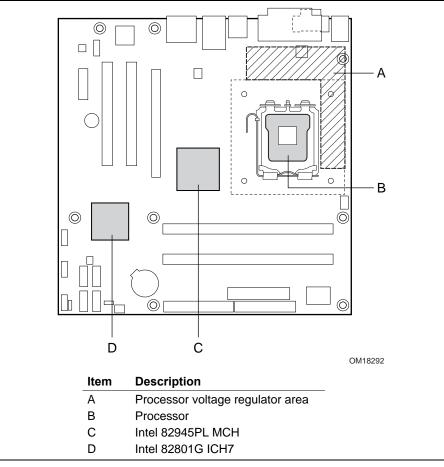


Figure 20. Localized High Temperature Zones

Table 30 provides maximum case temperatures for the components that are sensitive to thermal changes. The operating temperature, current load, or operating frequency could affect case temperatures. Maximum case temperatures are important when considering proper airflow to cool the board.

Component	Maximum Case Temperature
Intel Pentium 4 processor	For processor case temperature, see processor datasheets and processor specification updates
Intel 82945PL MCH	103 °C (under bias)
Intel 82801G ICH7	110 °C (under bias, without heatsink) 99 °C (under bias, with heatsink)

Table 30.	Thermal	Considerations	for	Components
-----------	---------	----------------	-----	------------

For information about	Refer to
Intel Pentium 4 processor datasheets and specification updates	Section 1.2, page 15

2.12 Reliability

The Mean Time Between Failures (MTBF) prediction is calculated using component and subassembly random failure rates. The calculation is based on the Bellcore Reliability Prediction Procedure, TR-NWT-000332, Issue 4, September 1991. The MTBF prediction is used to estimate repair rates and spare parts requirements.

The MTBF data is calculated from predicted data at 55 °C. The MTBF for the D945PLNM board is 117,195.79 hours.

2.13 Environmental

Table 31 lists the environmental specifications for the board.

Parameter	Specification	Specification					
Temperature							
Non-Operating	-40 °C to +70 °C						
Operating	0 °C to +55 °C						
Shock							
Unpackaged	50 g trapezoidal waveform						
	Velocity change of 170 incl	Velocity change of 170 inches/second ²					
Packaged	Half sine 2 millisecond						
	Product weight (pounds)	Free fall (inches)	Velocity change (inches/sec2)				
	<20	36	167				
	21-40	30	152				
	41-80	24	136				
	81-100	18	118				
Vibration		·	· ·				
Unpackaged	5 Hz to 20 Hz: 0.01 g ² Hz sloping up to 0.02 g ² Hz						
	20 Hz to 500 Hz: 0.02 g ² Hz (flat)						
Packaged	5 Hz to 40 Hz: 0.015 g ² Hz (flat)						
	40 Hz to 500 Hz: 0.015 g ² Hz sloping down to 0.00015 g ² Hz						

Table 31. Environmental Specifications

2.14 Regulatory Compliance

This section contains the following regulatory compliance information for Desktop Board D945PLNM:

- Safety regulations
- European Union Declaration of Conformity statement
- Product Ecology statements
- Electromagnetic Compatibility (EMC) regulations
- Product certification markings

2.14.1 Safety Regulations

Desktop Board D945PLNM complies with the safety regulations stated in Table 32 when correctly installed in a compatible host system.

Regulation	Title
UL 60950-1:2003/	Information Technology Equipment – Safety - Part 1: General
CSA C22.2 No. 60950-1-03	Requirements (USA and Canada)
EN 60950-1:2002	Information Technology Equipment – Safety - Part 1: General Requirements (European Union)
IEC 60950-1:2001, First Edition	Information Technology Equipment – Safety - Part 1: General Requirements (International)

Table 32. Safety Regulations

2.14.2 European Union Declaration of Conformity Statement

We, Intel Corporation, declare under our sole responsibility that the product Intel[®] Desktop Board D945PLNM is in conformity with all applicable essential requirements necessary for CE marking, following the provisions of the European Council Directive 89/336/EEC (EMC Directive) and Council Directive 73/23/EEC (Safety/Low Voltage Directive).

The product is properly CE marked demonstrating this conformity and is for distribution within all member states of the EU with no restrictions.

Œ

This product follows the provisions of the European Directives 89/336/EEC and 73/23/EEC.

Čeština Tento výrobek odpovídá požadavkům evropských směrnic 89/336/EEC a 73/23/EEC.

Dansk Dette produkt er i overensstemmelse med det europæiske direktiv 89/336/EEC & 73/23/EEC.

Dutch Dit product is in navolging van de bepalingen van Europees Directief 89/336/EEC & 73/23/EEC.

Eesti Antud toode vastab Euroopa direktiivides 89/336/EEC ja 73/23/EEC kehtestatud nõuetele.

Suomi Tämä tuote noudattaa EU-direktiivin 89/336/EEC & 73/23/EEC määräyksiä.

Français Ce produit est conforme aux exigences de la Directive Européenne 89/336/EEC & 73/23/EEC.

Deutsch Dieses Produkt entspricht den Bestimmungen der Europäischen Richtlinie 89/336/EEC & 73/23/EEC.

Ελληνικά Το παρόν προϊόν ακολουθεί τις διατάξεις των Ευρωπαϊκών Οδηγιών 89/336/ΕΟΚ και 73/23/ΕΟΚ.

Magyar E termék megfelel a 89/336/EEC és 73/23/EEC Európai Irányelv előírásainak.

Icelandic Þessi vara stenst reglugerð Evrópska Efnahags Bandalagsins númer 89/336/ EEC & 73/23/EEC.

Italiano Questo prodotto è conforme alla Direttiva Europea 89/336/EEC & 73/23/EEC.

Latviešu Šis produkts atbilst Eiropas Direktīvu 89/336/EEC un 73/23/EEC noteikumiem.

Lietuvių Šis produktas atitinka Europos direktyvų 89/336/EEC ir 73/23/EEC nuostatas.

Malti Dan il-prodott hu konformi mal-provvedimenti tad-Direttivi Ewropej 89/336/EEC u 73/23/EEC.

Norsk Dette produktet er i henhold til bestemmelsene i det europeiske direktivet 89/336/ EEC & 73/23/EEC.

Polski Niniejszy produkt jest zgodny z postanowieniami Dyrektyw Unii Europejskiej 89/336/EWG i 73/23/EWG.

Portuguese Este produto cumpre com as normas da Diretiva Européia 89/336/EEC & 73/23/EEC.

Español Este producto cumple con las normas del Directivo Europeo 89/336/EEC & 73/23/EEC.

Slovensky Tento produkt je v súlade s ustanoveniami európskych direktív 89/336/EEC a 73/23/EEC.

Slovenščina Izdelek je skladen z določbami evropskih direktiv 89/336/EGS in 73/23/EGS.

Svenska Denna produkt har tillverkats i enlighet med EG-direktiv 89/336/EEC & 73/23/EEC.

Türkçe Bu ürün, Avrupa Birliği'nin 89/336/EEC ve 73/23/EEC yönergelerine uyar.

2.14.3 Product Ecology Statements

The following information is provided to address worldwide product ecology concerns and regulations.

2.14.3.1 Disposal Considerations

This product contains the following materials that may be regulated upon disposal: lead solder on the printed wiring board assembly.

2.14.3.2 Recycling Considerations

As part of its commitment to environmental responsibility, Intel has implemented the Intel Product Recycling Program to allow retail consumers of Intel's branded products to return used products to select locations for proper recycling.

Please consult the <u>http://www.intel.com/intel/other/ehs/product_ecology/Recycling_Program.htm</u> for the details of this program, including the scope of covered products, available locations, shipping instructions, terms and conditions, etc.

中文

作为其对环境责任之承诺的部分,英特尔已实施 Intel Product Recycling Program (英特尔产品回收计划),以允许英特尔品牌产品的零售消费者将使用过的产品退还至指定地点作 恰当的重复使用处理。

请参考<u>http://www.intel.com/intel/other/ehs/product_ecology/Recycling_Program.htm</u> 了解此计划的详情,包括涉及产品之范围、回收地点、运送指导、条款和条件等。

Deutsch

Als Teil von Intels Engagement für den Umweltschutz hat das Unternehmen das Intel Produkt-Recyclingprogramm implementiert, das Einzelhandelskunden von Intel Markenprodukten ermöglicht, gebrauchte Produkte an ausgewählte Standorte für ordnungsgemäßes Recycling zurückzugeben.

Details zu diesem Programm, einschließlich der darin eingeschlossenen Produkte, verfügbaren Standorte, Versandanweisungen, Bedingungen usw., finden Sie auf der http://www.intel.com/intel/other/ehs/product_ecology/Recycling_Program.htm

Español

Como parte de su compromiso de responsabilidad medioambiental, Intel ha implantado el programa de reciclaje de productos Intel, que permite que los consumidores al detalle de los productos Intel devuelvan los productos usados en los lugares seleccionados para su correspondiente reciclado.

Consulte la <u>http://www.intel.com/intel/other/ehs/product_ecology/Recycling_Program.htm</u> para ver los detalles del programa, que incluye los productos que abarca, los lugares disponibles, instrucciones de envío, términos y condiciones, etc.

Français

Dans le cadre de son engagement pour la protection de l'environnement, Intel a mis en œuvre le programme Intel Product Recycling Program (Programme de recyclage des produits Intel) pour permettre aux consommateurs de produits Intel de recycler les produits usés en les retournant à des adresses spécifiées.

Visitez la page Web <u>http://www.intel.com/intel/other/ehs/product_ecology/Recycling_Program.htm</u> pour en savoir plus sur ce programme, à savoir les produits concernés, les adresses disponibles, les instructions d'expédition, les conditions générales, etc.

日本語

インテルでは、環境保護活動の一環として、使い終えたインテル ブランド製品を指定の場所へ返送していただき、リサイクルを適切に行えるよう、インテル製品リサイクル プログラムを発足させました。

対象製品、返送先、返送方法、ご利用規約など、このプログラムの詳細情報は、<u>http://www.intel.com/intel/o</u> <u>ther/ehs/product_ecology/Recycling_Program.htm</u>(英語)をご覧ください。

Malay

Sebagai sebahagian daripada komitmennya terhadap tanggungjawab persekitaran, Intel telah melaksanakan Program Kitar Semula Produk untuk membenarkan pengguna-pengguna runcit produk jenama Intel memulangkan produk terguna ke lokasi-lokasi terpilih untuk dikitarkan semula dengan betul.

Sila rujuk <u>http://www.intel.com/intel/other/ehs/product_ecology/Recycling_Program.htm</u> untuk mendapatkan butir-butir program ini, termasuklah skop produk yang dirangkumi, lokasi-lokasi tersedia, arahan penghantaran, terma & syarat, dsb.

Portuguese

Como parte deste compromisso com o respeito ao ambiente, a Intel implementou o Programa de Reciclagem de Produtos para que os consumidores finais possam enviar produtos Intel usados para locais selecionados, onde esses produtos são reciclados de maneira adequada.

Consulte o site <u>http://www.intel.com/intel/other/ehs/product_ecology/Recycling_Program.htm</u> (em Inglês) para obter os detalhes sobre este programa, inclusive o escopo dos produtos cobertos, os locais disponíveis, as instruções de envio, os termos e condições, etc.

Russian

В качестве части своих обязательств к окружающей среде, в Intel создана программа утилизации продукции Intel (Product Recycling Program) для предоставления конечным пользователям марок продукции Intel возможности возврата используемой продукции в специализированные пункты для должной утилизации.

Пожалуйста, обратитесь на веб-сайт

<u>http://www.intel.com/intel/other/ehs/product_ecology/Recycling_Program.htm</u> за информацией об этой программе, принимаемых продуктах, местах приема, инструкциях об отправке, положениях и условиях и т.д.

Türkçe

Intel, çevre sorumluluğuna bağımlılığının bir parçası olarak, perakende tüketicilerin Intel markalı kullanılmış ürünlerini belirlenmiş merkezlere iade edip uygun şekilde geri dönüştürmesini amaçlayan Intel Ürünleri Geri Dönüşüm Programı'nı uygulamaya koymuştur.

Bu programın ürün kapsamı, ürün iade merkezleri, nakliye talimatları, kayıtlar ve şartlar v.s dahil bütün ayrıntılarını ögrenmek için lütfen http://www.intel.com/intel/other/ehs/product_ecology/Recycling_Program.htm

Web sayfasına gidin.

2.14.3.3 Lead Free Desktop Board

The desktop board is lead free. Other box contents may contain lead.

Table 33. Lead Free Desktop Board

Description	Mark
Lead-Free: The symbol is used to identify electrical and electronic assemblies and components in which the lead (Pb) concentration level in any of the raw materials and the end product is not greater than 0.1% by weight (1000 ppm). This symbol is also used to indicate conformance to lead-free requirements and definitions adopted under the European Union's Restriction on Hazardous Substances (RoHS) directive, 2002/95/EC.	(Pla)

2.14.4 EMC Regulations

Desktop Board D945PLNM complies with the EMC regulations stated in Table 34 when correctly installed in a compatible host system.

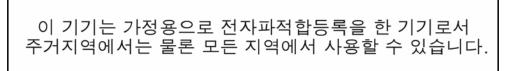
Regulation	Title	
FCC Class B	Title 47 of the Code of Federal Regulations, Parts 2 and 15, Subpart B, Radio Frequency Devices. (USA)	
ICES-003 (Class B)	Interference-Causing Equipment Standard, Digital Apparatus. (Canada)	
EN55022: 1998 (Class B)	Limits and methods of measurement of Radio Interference Characteristics of Information Technology Equipment. (European Union)	
EN55024: 1998	Information Technology Equipment – Immunity Characteristics Limits and methods of measurement. (European Union)	
AS/NZS CISPR 22 (Class B)	Australian Communications Authority, Standard for Electromagnetic Compatibility. (Australia and New Zealand)	
CISPR 22, 3rd Edition, (Class B)	Limits and methods of measurement of Radio Disturbance Characteristics of Information Technology Equipment. (International)	
CISPR 24: 1997	Information Technology Equipment – Immunity Characteristics – Limits and Methods of Measurement. (International)	
VCCI (Class B)	Voluntary Control for Interference by Information Technology Equipment. (Japan)	

Table 34. EMC Regulations

Japanese Kanji statement translation: this is a Class B product based on the standard of the Voluntary Control Council for Interference from Information Technology Equipment (VCCI). If this is used near a radio or television receiver in a domestic environment, it may cause radio interference. Install and use the equipment according to the instruction manual.

この装置は、情報処理装置等電波障害自主規制協議会(VCCI)の基準 に基づくクラスB情報技術装置です。この装置は、家庭環境で使用すること を目的としていますが、この装置がラジオやテレビジョン受信機に近接して 使用されると、受信障害を引き起こすことがあります。 取扱説明書に従って正しい取り扱いをして下さい。

Korean Class B statement translation: this is household equipment that is certified to comply with EMC requirements. You may use this equipment in residential environments and other non-residential environments.



2.14.5 Product Certification Markings (Board Level)

Desktop Board D945PLNM has the product certification markings shown in Table 35:

Table 35. Product Certification Markings

Description	Mark
UL joint US/Canada Recognized Component mark. Includes adjacent UL file number for Intel desktop boards: E210882.	
FCC Declaration of Conformity logo mark for Class B equipment. Includes Intel name and D945PLNM model designation.	FC Trade Name Model Number
CE mark. Declaring compliance to European Union (EU) EMC directive (89/336/EEC) and Low Voltage directive (73/23/EEC).	CE
Australian Communications Authority (ACA) C-tick mark. Includes adjacent Intel supplier code number, N-232.	C
Japan VCCI (Voluntary Control Council for Interference) mark.	V ©I
S. Korea MIC (Ministry of Information and Communication) mark.	
For information about MIC certification, go to	MIC
http://support.intel.com/support/motherboards/desktop/	
Taiwan BSMI (Bureau of Standards, Metrology and Inspections) mark. Includes adjacent Intel company number, D33025.	€
Printed wiring board manufacturer's recognition mark. Consists of a unique UL recognized manufacturer's logo, along with a flammability rating (solder side).	V-0

3 Overview of BIOS Features

What This Chapter Contains

3.1	Introduction	.73
3.2	BIOS Flash Memory Organization	.74
	Resource Configuration	
	System Management BIOS (SMBIOS)	
	Legacy USB Support	
	BIOS Updates	
	Boot Options	
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	BIOS Security Features	

3.1 Introduction

The boards use an Intel BIOS that is stored in the Serial Peripheral Interface Flash Memory (SPI Flash) and can be updated using a disk-based program. The SPI Flash contains the BIOS Setup program, POST, the PCI auto-configuration utility, and Plug and Play support.

The BIOS displays a message during POST identifying the type of BIOS and a revision code. The initial production BIOSs are identified as NM94510J.86A.

When the BIOS Setup configuration jumper is set to configure mode and the computer is poweredup, the BIOS compares the CPU version and the microcode version in the BIOS and reports if the two match.

The BIOS Setup program can be used to view and change the BIOS settings for the computer. The BIOS Setup program is accessed by pressing the $\langle F2 \rangle$ key after the Power-On Self-Test (POST) memory test begins and before the operating system boot begins. The menu bar is shown below.

Maintenance Main Advanced Security Power Boot Exit

■> NOTE

The maintenance menu is displayed only when the Desktop Board is in configure mode. Section 2.8 on page 56 shows how to put the Desktop Board in configure mode.

Table 36 lists the BIOS Setup program menu features.

Maintenance	Main	Advanced	Security	Power	Boot	Exit
Clears passwords and displays processor information	Displays processor and memory configuration	Configures advanced features available through the chipset	Sets passwords and security features	Configures power management features and power supply controls	Selects boot options	Saves or discards changes to Setup program options

 Table 36.
 BIOS Setup Program Menu Bar

Table 37 lists the function keys available for menu screens.

Table 37.	BIOS Setup Program Function Keys
-----------	---

BIOS Setup Program Function Key	Description	
< →> 0r < →>	Selects a different menu screen (Moves the cursor left or right)	
<^> or <↓>	Selects an item (Moves the cursor up or down)	
<tab></tab>	Selects a field (Not implemented)	
<enter></enter>	Executes command or selects the submenu	
<f9></f9>	Load the default configuration values for the current menu	
<f10></f10>	Save the current values and exits the BIOS Setup program	
<esc></esc>	Exits the menu	

3.2 BIOS Flash Memory Organization

The Serial Peripheral Interface Flash Memory (SPI Flash) includes an 8 Mbit (1024 KB) flash memory device.

3.3 Resource Configuration

3.3.1 PCI Autoconfiguration

The BIOS can automatically configure PCI devices. PCI devices may be onboard or add-in cards. Autoconfiguration lets a user insert or remove PCI cards without having to configure the system. When a user turns on the system after adding a PCI card, the BIOS automatically configures interrupts, the I/O space, and other system resources. Any interrupts set to Available in Setup are considered to be available for use by the add-in card.

3.3.2 PCI IDE Support

If you select Auto in the BIOS Setup program, the BIOS automatically sets up the PCI IDE connector with independent I/O channel support. The IDE interface supports hard drives up to ATA-66/100 and recognizes any ATAPI compliant devices, including CD-ROM drives, tape drives, and Ultra DMA drives. The interface also supports second-generation SATA drives. The BIOS determines the capabilities of each drive and configures them to optimize capacity and performance. To take advantage of the high capacities typically available today, hard drives are

automatically configured for Logical Block Addressing (LBA) and to PIO Mode 3 or 4, depending on the capability of the drive. You can override the auto-configuration options by specifying manual configuration in the BIOS Setup program.

To use ATA-66/100 features the following items are required:

- An ATA-66/100 peripheral device
- An ATA-66/100 compatible cable
- ATA-66/100 operating system device drivers

■> NOTE

Do not connect an ATA device as a slave on the same IDE cable as an ATAPI master device. For example, do not connect an ATA hard drive as a slave to an ATAPI CD-ROM drive.

3.4 System Management BIOS (SMBIOS)

SMBIOS is a Desktop Management Interface (DMI) compliant method for managing computers in a managed network.

The main component of SMBIOS is the Management Information Format (MIF) database, which contains information about the computing system and its components. Using SMBIOS, a system administrator can obtain the system types, capabilities, operational status, and installation dates for system components. The MIF database defines the data and provides the method for accessing this information. The BIOS enables applications such as third-party management software to use SMBIOS. The BIOS stores and reports the following SMBIOS information:

- BIOS data, such as the BIOS revision level
- Fixed-system data, such as peripherals, serial numbers, and asset tags
- Resource data, such as memory size, cache size, and processor speed
- Dynamic data, such as event detection and error logging

Non-Plug and Play operating systems, such as Windows NT*, require an additional interface for obtaining the SMBIOS information. The BIOS supports an SMBIOS table interface for such operating systems. Using this support, an SMBIOS service-level application running on a non-Plug and Play operating system can obtain the SMBIOS information.

3.5 Legacy USB Support

Legacy USB support enables USB devices to be used even when the operating system's USB drivers are not yet available. Legacy USB support is used to access the BIOS Setup program, and to install an operating system that supports USB.

Legacy USB support operates as follows:

- 1. When you apply power to the computer, legacy support is disabled.
- 2. POST begins.
- 3. Legacy USB support is enabled by the BIOS allowing you to use a USB keyboard to enter and configure the BIOS Setup program and the maintenance menu.
- 4. POST completes.

- 5. The operating system loads. While the operating system is loading, USB keyboards and mice are recognized and may be used to configure the operating system.
- 6. After the operating system loads the USB drivers, all legacy and non-legacy USB devices are recognized by the operating system, and Legacy USB support from the BIOS is no longer used.

To install an operating system that supports USB, follow the operating system's installation instructions.

3.6 BIOS Updates

The BIOS can be updated using either of the following utilities, which are available on the Intel World Wide Web site:

- Intel[®] Express BIOS Update utility, which enables automated updating while in the Windows environment. Using this utility, the BIOS can be updated from a file on a hard disk, a 1.44 MB diskette, or a CD-ROM, or from the file location on the Web.
- Intel[®] Flash Memory Update Utility, which requires creation of a boot diskette and manual rebooting of the system. Using this utility, the BIOS can be updated from a file on a 1.44 MB diskette (from a legacy diskette drive or an LS-120 diskette drive) or a CD-ROM.

Both utilities verify that the updated BIOS matches the target system to prevent accidentally installing an incompatible BIOS.

≡> NOTE

Review the instructions distributed with the upgrade utility before attempting a BIOS update.

For information about	Refer to	
The Intel World Wide Web site	Section 1.2, page 15	

3.6.1 Language Support

The BIOS Setup program and help messages are supported in US English. Additional languages are available in the Integrator's Toolkit utility. Check the Intel website for details.

3.6.2 Custom Splash Screen

During POST, an Intel[®] splash screen is displayed by default. This splash screen can be augmented with a custom splash screen. The Integrator's Toolkit that is available from Intel can be used to create a custom splash screen.

■> NOTE

If you add a custom splash screen, it will share space with the Intel branded logo.

For information about	Refer to	
The Intel World Wide Web site	Section 1.2, page 15	

3.7 Boot Options

In the BIOS Setup program, the user can choose to boot from a diskette drive, hard drives, CD-ROM, or the network. The default setting is for the diskette drive to be the first boot device, the hard drive second, and the ATAPI CD-ROM third. The fourth device is disabled.

3.7.1 CD-ROM Boot

Booting from CD-ROM is supported in compliance to the El Torito bootable CD-ROM format specification. Under the Boot menu in the BIOS Setup program, ATAPI CD-ROM is listed as a boot device. Boot devices are defined in priority order. Accordingly, if there is not a bootable CD in the CD-ROM drive, the system will attempt to boot from the next defined drive.

3.7.2 Network Boot

The network can be selected as a boot device. This selection allows booting from the onboard LAN or a network add-in card with a remote boot ROM installed.

Pressing the <F12> key during POST automatically forces booting from the LAN. To use this key during POST, the User Access Level in the BIOS Setup program's Security menu must be set to Full.

3.7.3 Booting Without Attached Devices

For use in embedded applications, the BIOS has been designed so that after passing the POST, the operating system loader is invoked even if the following devices are not present:

- Video adapter
- Keyboard
- Mouse

3.7.4 Changing the Default Boot Device During POST

Pressing the $\langle F10 \rangle$ key during POST causes a boot device menu to be displayed. This menu displays the list of available boot devices (as set in the BIOS setup program's Boot Device Priority Submenu). Table 38 lists the boot device menu options.

Boot Device Menu Function Keys	Description
<1> or <↓>	Selects a default boot device
<enter></enter>	Exits the menu, saves changes, and boots from the selected device
<esc></esc>	Exits the menu without saving changes

Table 38. Boot Device Menu Options

3.8 Adjusting Boot Speed

These factors affect system boot speed:

- Selecting and configuring peripherals properly
- Optimized BIOS boot parameters

3.8.1 Peripheral Selection and Configuration

The following techniques help improve system boot speed:

- Choose a hard drive with parameters such as "power-up to data ready" less than eight seconds, that minimize hard drive startup delays.
- Select a CD-ROM drive with a fast initialization rate. This rate can influence POST execution time.
- Eliminate unnecessary add-in adapter features, such as logo displays, screen repaints, or mode changes in POST. These features may add time to the boot process.
- Try different monitors. Some monitors initialize and communicate with the BIOS more quickly, which enables the system to boot more quickly.

3.8.2 BIOS Boot Optimizations

Use of the following BIOS Setup program settings reduces the POST execution time.

- In the Boot Menu, set the hard disk drive as the first boot device. As a result, the POST does not first seek a diskette drive, which saves about one second from the POST execution time.
- In the Peripheral Configuration submenu, disable the LAN device if it will not be used. This can reduce up to four seconds of option ROM boot time.

≡> NOTE

It is possible to optimize the boot process to the point where the system boots so quickly that the Intel logo screen (or a custom logo splash screen) will not be seen. Monitors and hard disk drives with minimum initialization times can also contribute to a boot time that might be so fast that necessary logo screens and POST messages cannot be seen.

This boot time may be so fast that some drives might be not be initialized at all. If this condition should occur, it is possible to introduce a programmable delay ranging from three to 30 seconds (using the Hard Disk Pre-Delay feature of the Advanced Menu in the Drive Configuration Submenu of the BIOS Setup program).

3.9 BIOS Security Features

The BIOS includes security features that restrict access to the BIOS Setup program and who can boot the computer. A supervisor password and a user password can be set for the BIOS Setup program and for booting the computer, with the following restrictions:

- The supervisor password gives unrestricted access to view and change all the Setup options in the BIOS Setup program. This is the supervisor mode.
- The user password gives restricted access to view and change Setup options in the BIOS Setup program. This is the user mode.
- If only the supervisor password is set, pressing the <Enter> key at the password prompt of the BIOS Setup program allows the user restricted access to Setup.
- If both the supervisor and user passwords are set, users can enter either the supervisor password or the user password to access Setup. Users have access to Setup respective to which password is entered.
- Setting the user password restricts who can boot the computer. The password prompt will be displayed before the computer is booted. If only the supervisor password is set, the computer boots without asking for a password. If both passwords are set, the user can enter either password to boot the computer.
- For enhanced security, use different passwords for the supervisor and user passwords.
- Valid password characters are A-Z, a-z, and 0-9. Passwords may be up to 16 characters in length.

Table 39 shows the effects of setting the supervisor password and user password. This table is for reference only and is not displayed on the screen.

Password Set	Supervisor Mode	User Mode	Setup Options	Password to Enter Setup	Password During Boot
Neither	Can change all options (Note)	Can change all options (Note)	None	None	None
Supervisor only	Can change all options	Can change a limited number of options	Supervisor Password	Supervisor	None
User only	N/A	Can change all options	Enter Password Clear User Password	User	User
Supervisor and user set	Can change all options	Can change a limited number of options	Supervisor Password Enter Password	Supervisor or user	Supervisor or user

 Table 39.
 Supervisor and User Password Functions

Note: If no password is set, any user can change all Setup options.

Intel Desktop Board D945PLNM Technical Product Specification

4 Error Messages and Beep Codes

What This Chapter Contains

4.1	Speaker	81
	BIOS Beep Codes	
	BIOS Error Messages	
	Port 80h POST Codes	

4.1 Speaker

The board-mounted speaker provides audible error code (beep code) information during POST.

For information about	Refer to	
The location of the onboard speaker	Figure 1, page 12	

4.2 BIOS Beep Codes

Whenever a recoverable error occurs during POST, the BIOS displays an error message describing the problem (see Table 40).

Table 40. Beep Codes

Туре	Pattern	Frequency
Memory error	Three long beeps	1280 Hz
Thermal warning	Four alternating beeps:	High tone: 2000 Hz
	High tone, low tone, high tone, low tone	Low tone: 1600 Hz

4.3 BIOS Error Messages

Table 41 lists the error messages and provides a brief description of each.

Table 41. BIOS Error Messages

Error Message	Explanation
CMOS Battery Low	The battery may be losing power. Replace the battery soon.
CMOS Checksum Bad The CMOS checksum is incorrect. CMOS memory may have been corrupted. Run Setup to reset values.	
Memory Size Decreased	Memory size has decreased since the last boot. If no memory was removed then memory may be bad.
No Boot Device Available	System did not find a device to boot.

4.4 Port 80h POST Codes

During the POST, the BIOS generates diagnostic progress codes (POST-codes) to I/O port 80h. If the POST fails, execution stops and the last POST code generated is left at port 80h. This code is useful for determining the point where an error occurred.

Displaying the POST-codes requires a PCI bus add-in card, often called a POST card. The POST card can decode the port and display the contents on a medium such as a seven-segment display.

■> NOTE

The POST card must be installed in PCI bus connector 1.

The following tables provide information about the POST codes generated by the BIOS:

- Table 42 lists the Port 80h POST code ranges
- Table 43 lists the Port 80h POST codes themselves
- Table 44 lists the Port 80h POST sequence

■> NOTE

In the tables listed above, all POST codes and range values are listed in hexadecimal.

Range	Category/Subsystem
00 – 0F	Debug codes: Can be used by any PEIM/driver for debug.
10 – 1F	Host Processors: 1F is an unrecoverable CPU error.
20 – 2F	Memory/Chipset: 2F is no memory detected or no useful memory detected.
30 – 3F	Recovery: 3F indicated recovery failure.
40 – 4F	Reserved for future use.
50 – 5F	I/O Busses: PCI, USB, ISA, ATA, etc. 5F is an unrecoverable error. Start with PCI.
60 – 6F	Reserved for future use (for new busses).
70 – 7F	Output Devices: All output consoles. 7F is an unrecoverable error.
80 – 8F	Reserved for future use (new output console codes).
90 – 9F	Input devices: Keyboard/Mouse. 9F is an unrecoverable error.
A0 – AF	Reserved for future use (new input console codes).
B0 – BF	Boot Devices: Includes fixed media and removable media. BF is an unrecoverable error.
C0 – CF	Reserved for future use.
D0 – DF	Boot device selection.
E0 – FF	F0 – FF: FF processor exception.
	E0 – EE: Miscellaneous codes. See Table 43.
	EF boot/S3: resume failure.

Table 42. Port 80h POST Code Ranges

POST Code	Description of POST Operation
	Host Processor
10	Power-on initialization of the host processor (Boot Strap Processor)
11	Host processor Cache initialization (including APs)
12	Starting Application processor initialization
13	SMM initialization
	Chipset
21	Initializing a chipset component
	Memory
22	Reading SPD from memory DIMMs
23	Detecting presence of memory DIMMs
24	Programming timing parameters in the memory controller and the DIMMs
25	Configuring memory
26	Optimizing memory settings
27	Initializing memory, such as ECC init
28	Testing memory
	PCI Bus
50	Enumerating PCI busses
51	Allocating resources to PCI bus
52	Hot Plug PCI controller initialization
53 – 57	Reserved for PCI Bus
	USB
58	Resetting USB bus
59	Reserved for USB
	ATA/ATAPI/SATA
5A	Resetting PATA/SATA bus and all devices
5B	Reserved for ATA
	SMBus
5C	Resetting SMBUS
5D	Reserved for SMBUS
	Local Console
70	Resetting the VGA controller
71	Disabling the VGA controller
72	Enabling the VGA controller
	Remote Console
78	Resetting the console controller
79	Disabling the console controller
7A	Enabling the console controller

Table 43. Port 80h POST Codes

continued

POST Code	Description of POST Operation
	Keyboard (PS2 or USB)
90	Resetting keyboard
91	Disabling keyboard
92	Detecting presence of keyboard
93	Enabling keyboard
94	Clearing keyboard input buffer
95	Instructing keyboard controller to run Self Test (PS2 only)
	Mouse (PS2 or USB)
98	Resetting mouse
99	Disabling mouse
9A	Detecting presence of mouse
9B	Enabling mouse
	Fixed Media
B0	Resetting fixed media
B1	Disabling fixed media
B2	Detecting presence of a fixed media (IDE hard drive detection etc.)
B3	Enabling/configuring a fixed media
	Removable media
B8	Resetting removable media
B9	Disabling removable media
BA	Detecting presence of a removable media (IDE, CD-ROM detection, etc.)
BC	Enabling/configuring a removable media
	BDS
Dy	Trying boot selection y (y=0 to 15)
	PEI Core
E0	Started dispatching PEIMs (emitted on first report of EFI_SW_PC_INIT_BEGIN EFI_SW_PEI_PC_HANDOFF_TO_NEXT)
E2	Permanent memory found
E1, E3	Reserved for PEI/PEIMs
	DXE Core
E4	Entered DXE phase
E5	Started dispatching drivers
E6	Started connecting drivers

Table 43. Port 80h POST Codes (continued)

continued

POST Code	Description of POST Operation
	DXE Drivers
E7	Waiting for user input
E8	Checking password
E9	Entering BIOS setup
EA	TBD – Flash Update
EB	Calling Legacy Option ROMs
EE	TBD – Calling INT 19. One beep unless silent boot is enabled
EF	TBD – Unrecoverable Boot failure/S3 resume failure
	Runtime Phase/EFI OS Boot
F4	Entering Sleep state
F5	Exiting Sleep state
F8	EFI boot service ExitBootServices () has been called
F9	EFI runtime service SetVirtualAddressMap () has been called
FA	EFI runtime service ResetSystem () has been called
	PEIMs/Recovery
30	Crisis Recovery has initiated per User request
31	Crisis Recovery has initiated by software (corrupt flash)
34	Loading recovery capsule
35	Handing off control to the recovery capsule
3F	Unable to recover

Table 43. Port 80h POST Codes (continued)

21Initializing a chipset component22Reading SPD from memory DIMMs23Detecting presence of memory DIMMs25Configuring memory28Testing memory34Loading recovery capsuleE4Entered DXE phase12Starting Application processor initialization13SMM initialization50Enumerating PCI busses51Allocating resourced to PCI bus92Detecting the presence of the keyboard90Resetting keyboard94Clearing keyboard95Keyboard Self TestEBCalling Video BIOS58Resetting USB bus5AResetting keyboard90Resetting keyboard91Clearing keyboard92Detecting the presence of the keyboard93Keyboard Self TestEBCalling Video BIOS58Resetting USB bus5AResetting keyboard90Resetting keyboard91Clearing keyboard92Detecting the presence of the keyboard93Resetting keyboard94Clearing keyboard95Resetting keyboard96Resetting keyboard97Resetting keyboard98Testing memory99Resetting keyboard90Resetting keyboard91Testing memory92Detecting the presence of the keyboard93Resetting keyboard94Clearing keyboard <td< th=""><th>POST Code</th><th>Description</th></td<>	POST Code	Description
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28Testing memory34Loading recovery capsuleE4Entered DXE phase12Starting Application processor initialization13SMM initialization50Enumerating PCI busses51Allocating resourced to PCI bus92Detecting the presence of the keyboard90Resetting keyboard94Clearing keyboard input buffer95Keyboard Self TestEBCalling Video BIOS58Resetting PATA/SATA bus and all devices92Detecting the presence of the keyboard94Clearing keyboard95Keyboard Self TestEBCalling Video BIOS58Resetting USB bus5AResetting PATA/SATA bus and all devices92Detecting the presence of the keyboard90Resetting keyboard91Clearing keyboard92Detecting the presence of the keyboard93Resetting keyboard94Clearing keyboard95Video BIOS56Resetting keyboard90Resetting keyboard91Clearing keyboard92Detecting the presence of the keyboard93Resetting path buffer54Resetting path buffer55Keyboard input buffer56Resetting path buffer57Waiting for user input61INT 19	23	Detecting presence of memory DIMMs
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EBCalling Video BIOS58Resetting USB bus5AResetting PATA/SATA bus and all devices92Detecting the presence of the keyboard90Resetting keyboard94Clearing keyboard input buffer5AResetting PATA/SATA bus and all devices28Testing memory90Resetting keyboard94Clearing keyboard91Resetting keyboard92Detecting the presence of the keyboard93Resetting keyboard input buffer54Festing memory90Resetting keyboard91Clearing keyboard input buffer93Clearing keyboard input buffer94Clearing keyboard input buffer94Clearing keyboard input buffer95Waiting for user input96INT 19	94	Clearing keyboard input buffer
58Resetting USB bus5AResetting PATA/SATA bus and all devices92Detecting the presence of the keyboard90Resetting keyboard94Clearing keyboard input buffer5AResetting PATA/SATA bus and all devices28Testing memory90Resetting keyboard94Clearing keyboard90Resetting keyboard91Resetting keyboard92941Clearing keyboard input buffer94Clearing keyboard94Clearing keyboard input buffer94Clearing keyboard input buffer94Clearing keyboard input buffer95INT 19	95	Keyboard Self Test
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92Detecting the presence of the keyboard90Resetting keyboard94Clearing keyboard input buffer5AResetting PATA/SATA bus and all devices28Testing memory90Resetting keyboard94Clearing keyboard input bufferE7Waiting for user input01INT 19	58	Resetting USB bus
90Resetting keyboard94Clearing keyboard input buffer5AResetting PATA/SATA bus and all devices28Testing memory90Resetting keyboard94Clearing keyboard input bufferE7Waiting for user input01INT 19	5A	Resetting PATA/SATA bus and all devices
94Clearing keyboard input buffer5AResetting PATA/SATA bus and all devices28Testing memory90Resetting keyboard94Clearing keyboard input bufferE7Waiting for user input01INT 19	92	Detecting the presence of the keyboard
5AResetting PATA/SATA bus and all devices28Testing memory90Resetting keyboard94Clearing keyboard input bufferE7Waiting for user input01INT 19	90	Resetting keyboard
28 Testing memory 90 Resetting keyboard 94 Clearing keyboard input buffer E7 Waiting for user input 01 INT 19	94	Clearing keyboard input buffer
90 Resetting keyboard 94 Clearing keyboard input buffer E7 Waiting for user input 01 INT 19	5A	Resetting PATA/SATA bus and all devices
94 Clearing keyboard input buffer E7 Waiting for user input 01 INT 19	28	Testing memory
E7 Waiting for user input 01 INT 19	90	Resetting keyboard
01 INT 19	94	Clearing keyboard input buffer
	E7	Waiting for user input
00 Ready to boot	01	INT 19
	00	Ready to boot

 Table 44.
 Typical Port 80h POST Sequence